

LCFC Confidential

E455

NM-A231 Schematics

AMD Kaveri 2.0 Processor with DDR3L + Bolton FCH

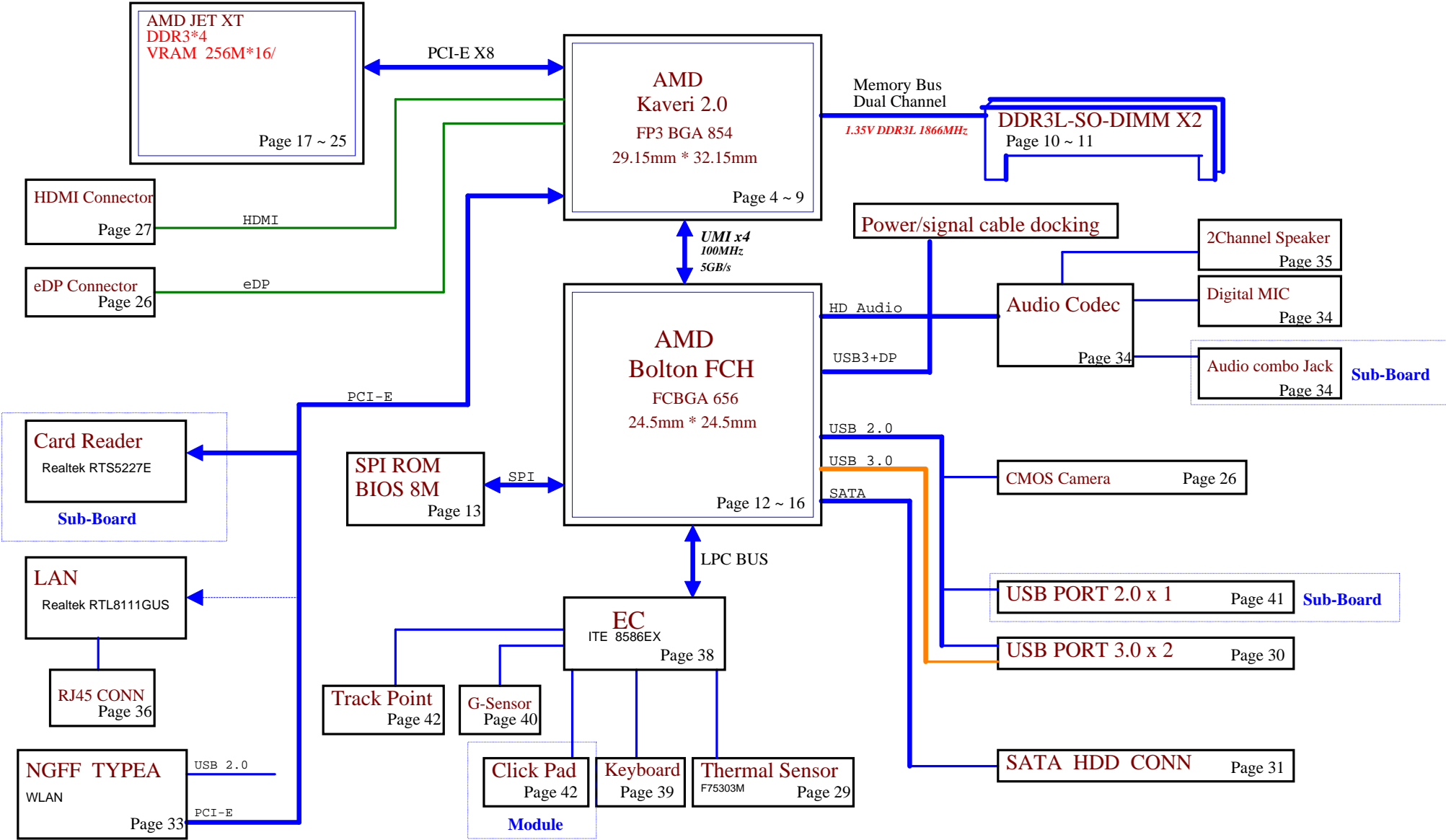
GPU AMD JET XT

2014-7-7

REV:1.0

Security Classification		LC Future Center Secret Data		Title	
Issued Date		2012/12/05		Cover Page	
Deciphered Date		2014/12/05		Size	
CUSTOM		CUSTOM		Document Number	
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Rev		0.2		LCFC	

Model Name : AAVE1



Voltage Rails (O --> Means ON , X --> Means OFF)

Power Plane State	B+	+3VALW +5VALW	+1.35V	+5VS +3VS +0.675VS +0.95VS_VDDP +0.95VS_VDDR +1.8VS_VDDA +1.1VS +VDD_CORE +VDDNB_CORE +VGA_CORE +3VS_VGA +1.8VS_VGA +1.5VS_VGA +0.95VS_VGA
S0	O	O	O	O
S3	O	O	O	X
S5 S4/AC Only	O	O	X	X
S5 S4 Battery only	O	X	X	X
S5 S4 AC & Battery don't exist	X	X	X	X

STATE \ SIGNAL	SLP_S1#	SLP_S3#	SLP_S4#	SLP_S5#	+VALW	+V	+VS	Clock
Full ON	HIGH	HIGH	HIGH	HIGH	ON	ON	ON	ON
S1(Power On Suspend)	LOW	HIGH	HIGH	HIGH	ON	ON	ON	LOW
S3 (Suspend to RAM)	LOW	LOW	HIGH	HIGH	ON	ON	OFF	OFF
S4 (Suspend to Disk)	LOW	LOW	LOW	HIGH	ON	OFF	OFF	OFF
S5 (Soft OFF)	LOW	LOW	LOW	LOW	ON	OFF	OFF	OFF

USB Port Table

USB 2.0	USB 3.0	Port	Port	3 External USB Port
EHCI			0	USB 2.0 Port
			1	
			2	
			3	
			4	
EHCI			5	Camera
			6	WLAN/BT
			7	FPR
			8	
			9	
	xHCI	0	10	USB 3.0 Port
		1	11	
	xHCI	2	12	USB 3.0 Port
		3	13	Docking port

BOM Structure Table

BTO Item	BOM Structure
Un-mount	@
Connector	ME@
GPU	DIS@
UMA	UMA@
VRAM Option	X76@
RF Part Option	RF@
EMI Part Option	EMI@
ESD Part Option	ESD@
JET GPU	JET@
TOPAZ GPU	TOPAZ@
Quad Core APU	QC@
14 MB	14@

PCIE PORT LIST

Port	Device
0	LAN
1	Card Reader
2	WLAN
3	
4	
5	
6	
7	

EC SM Bus1 address

Device	Address
Smart Battery	0001 011X b

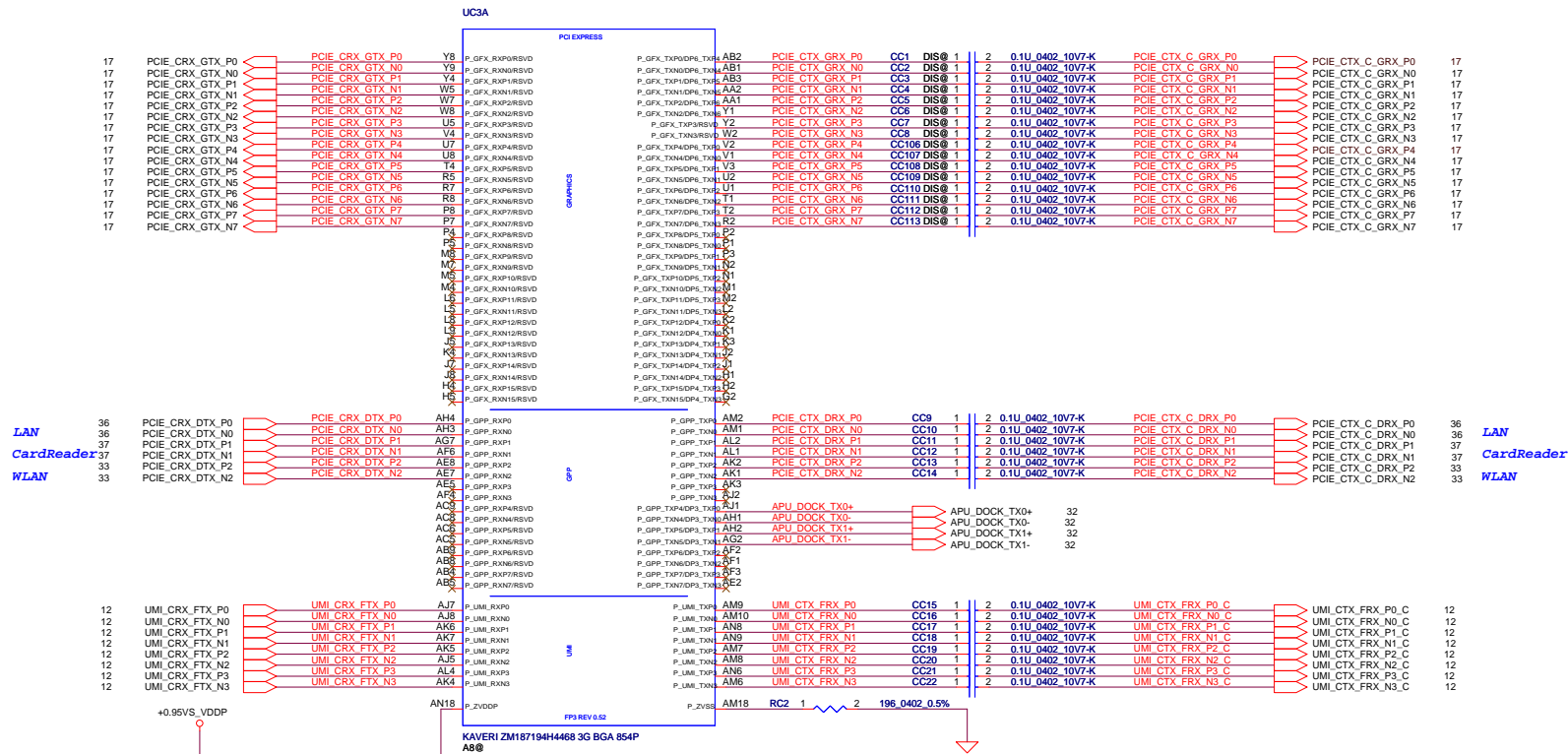
EC SM Bus3 address

Device	Address
Thermal Sensor	

FCH SM Bus address

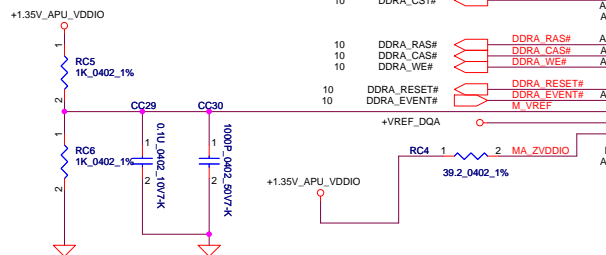
Device	Address
DDR DIMM1	
DDR DIMM2	

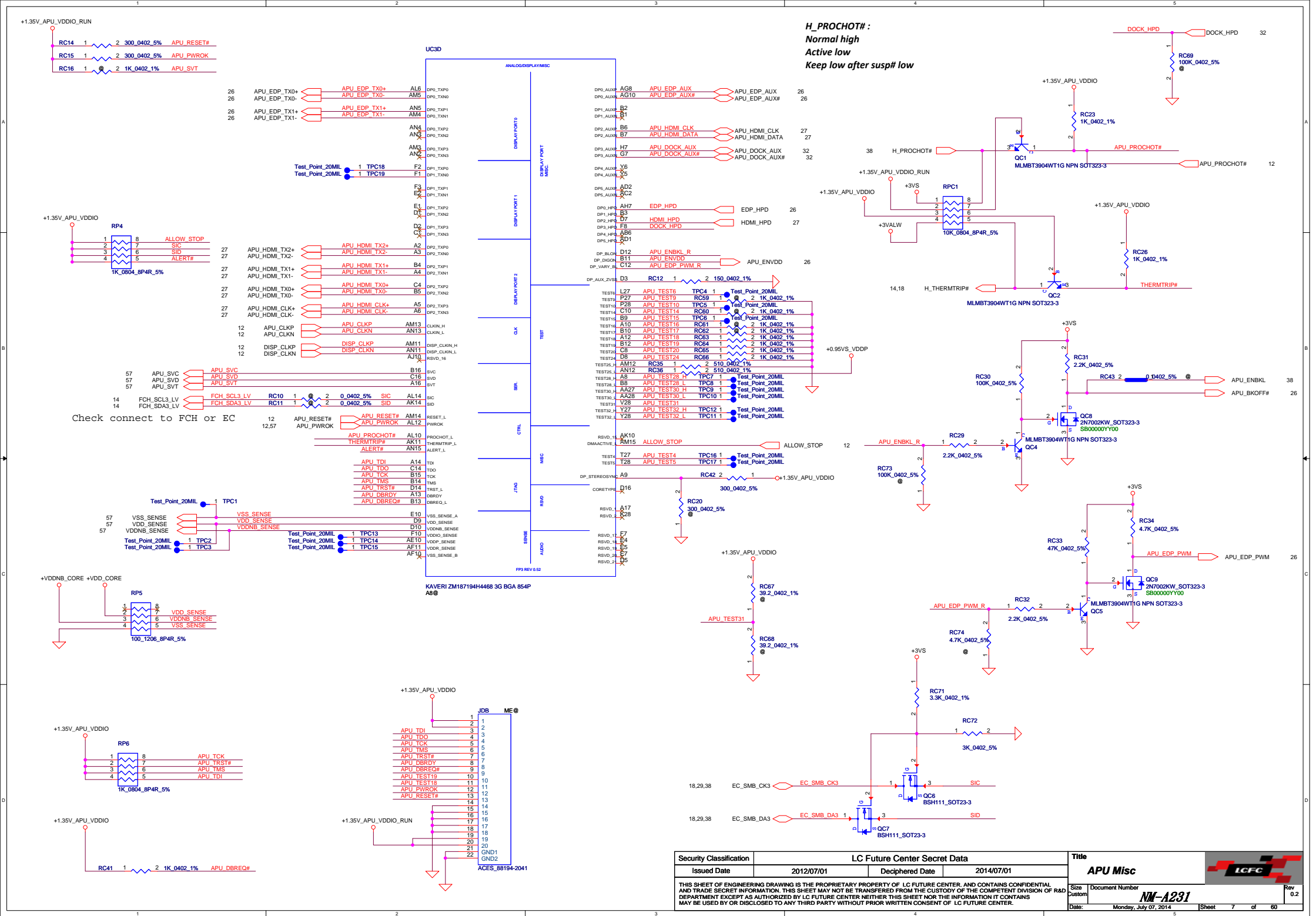


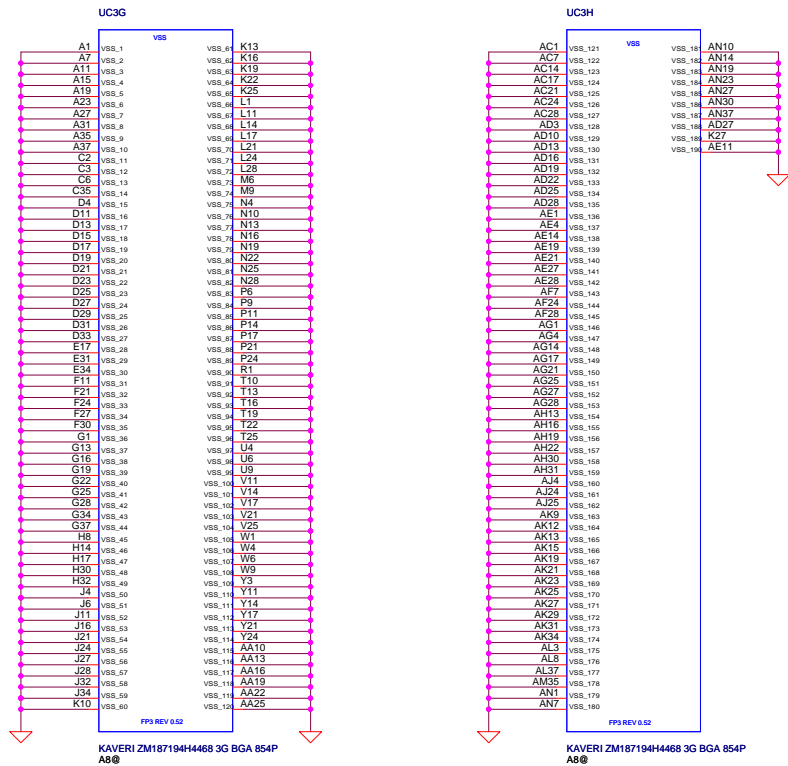




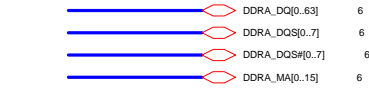
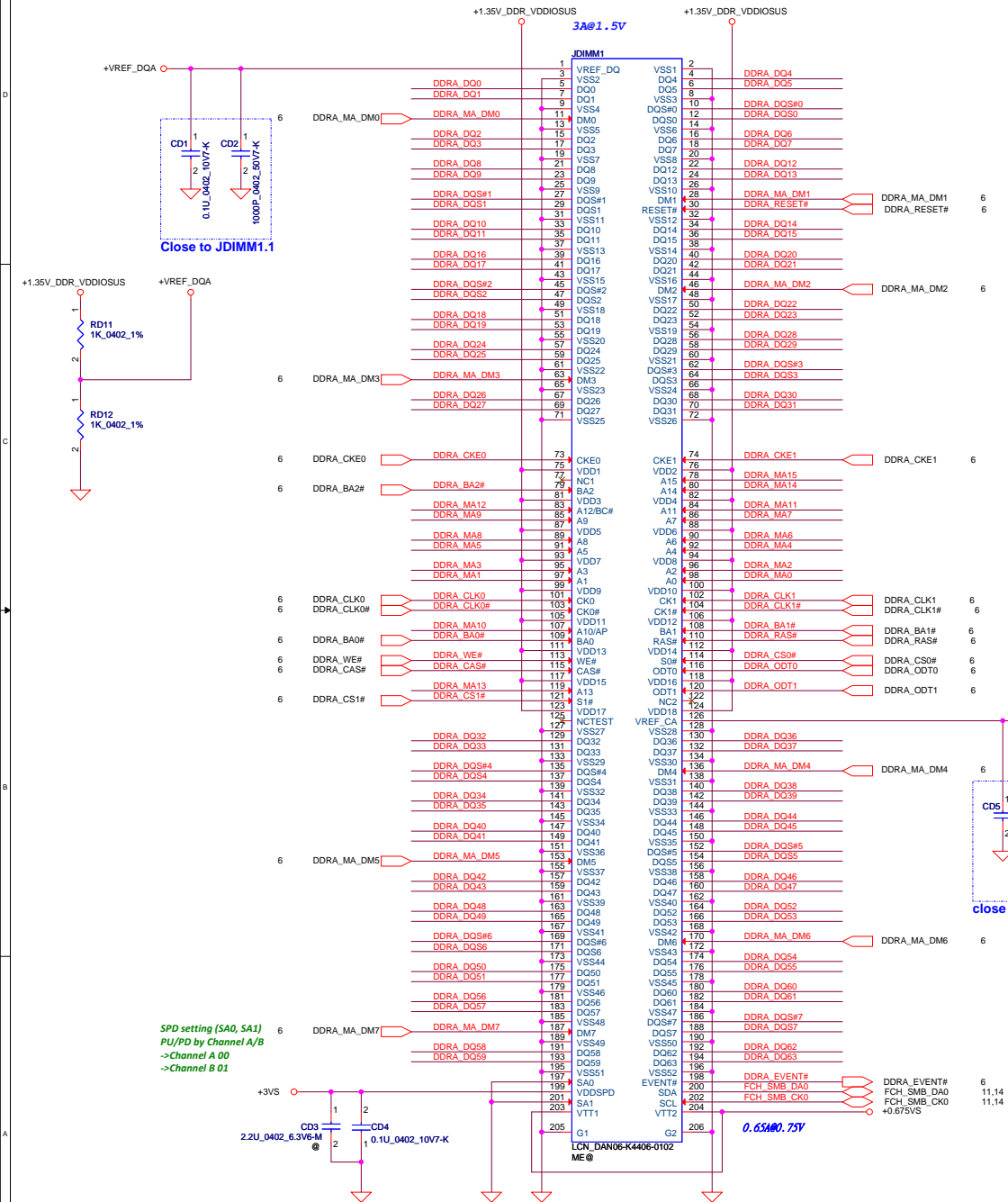
KAVERI ZM187194H4468 3G BGA 854P
A8@



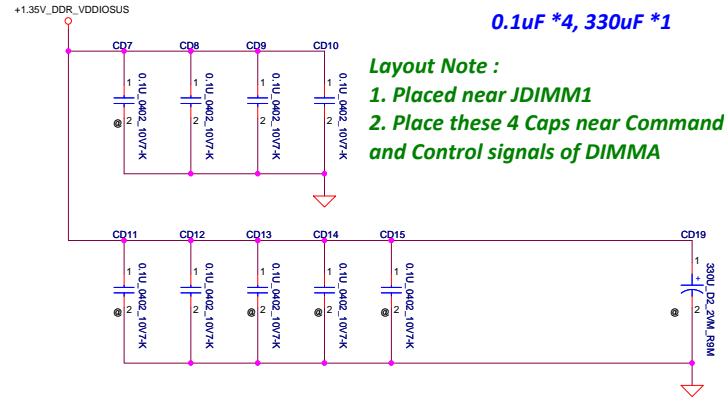




DDR3L SO-DIMM A

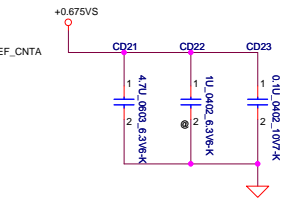


DDR Decoupling

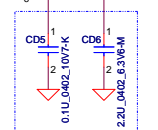


Layout Note :

1. Placed near JDIMM1
2. Place these 4 Caps near Command and Control signals of DIMMA

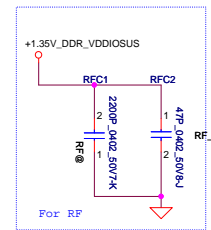
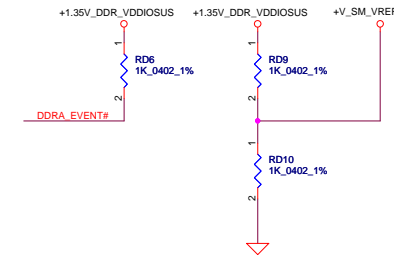



**Layout Note : Placed near
JDIMM1.Pin203, 204**



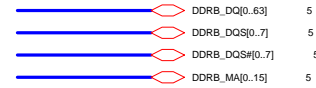
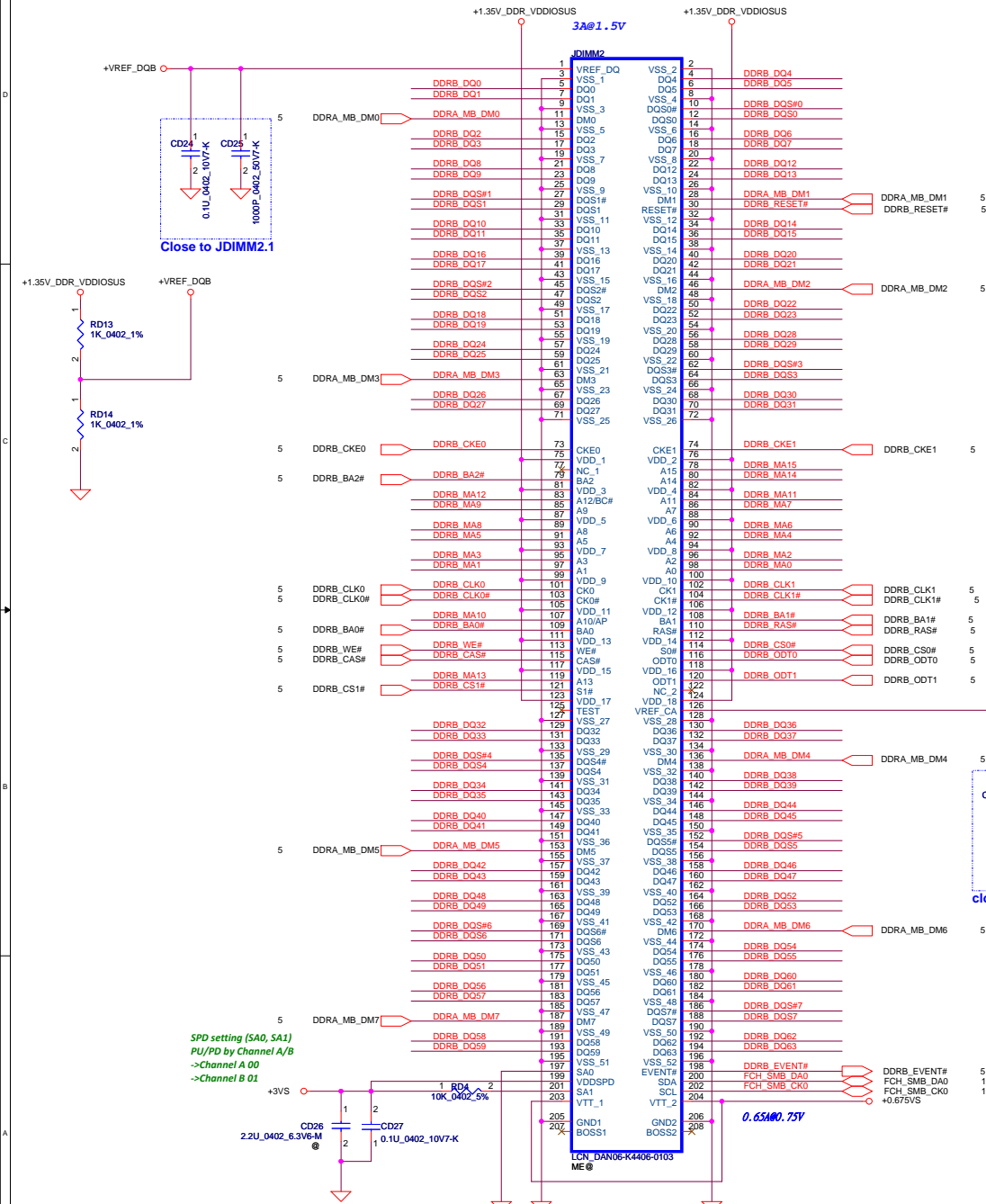
close to JDIMM1.126

All VREF traces should have 20 mil trace width

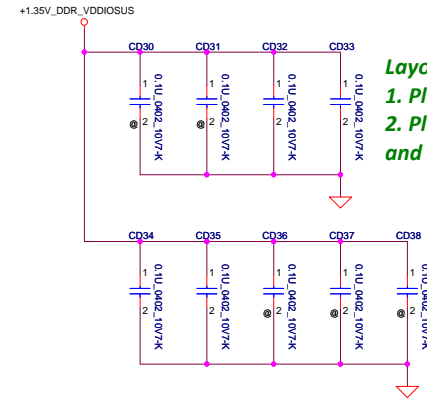


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DDR3L SO-DIMM B

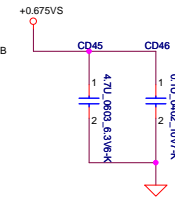


DDR Decoupling

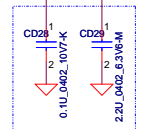


Layout Note :

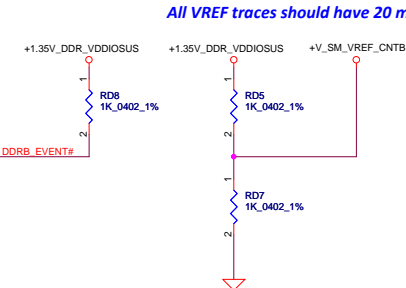
1. Placed near JDIMM2
2. Place these 4 Caps near Command and Control signals of DIMMB



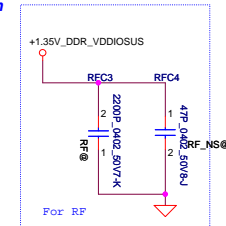
**Layout Note : Placed near
JDIMM2.Pin203, 204**




close to JDIMM2.126

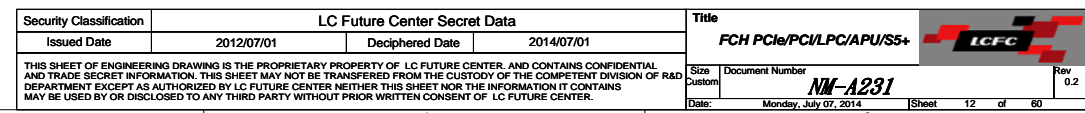


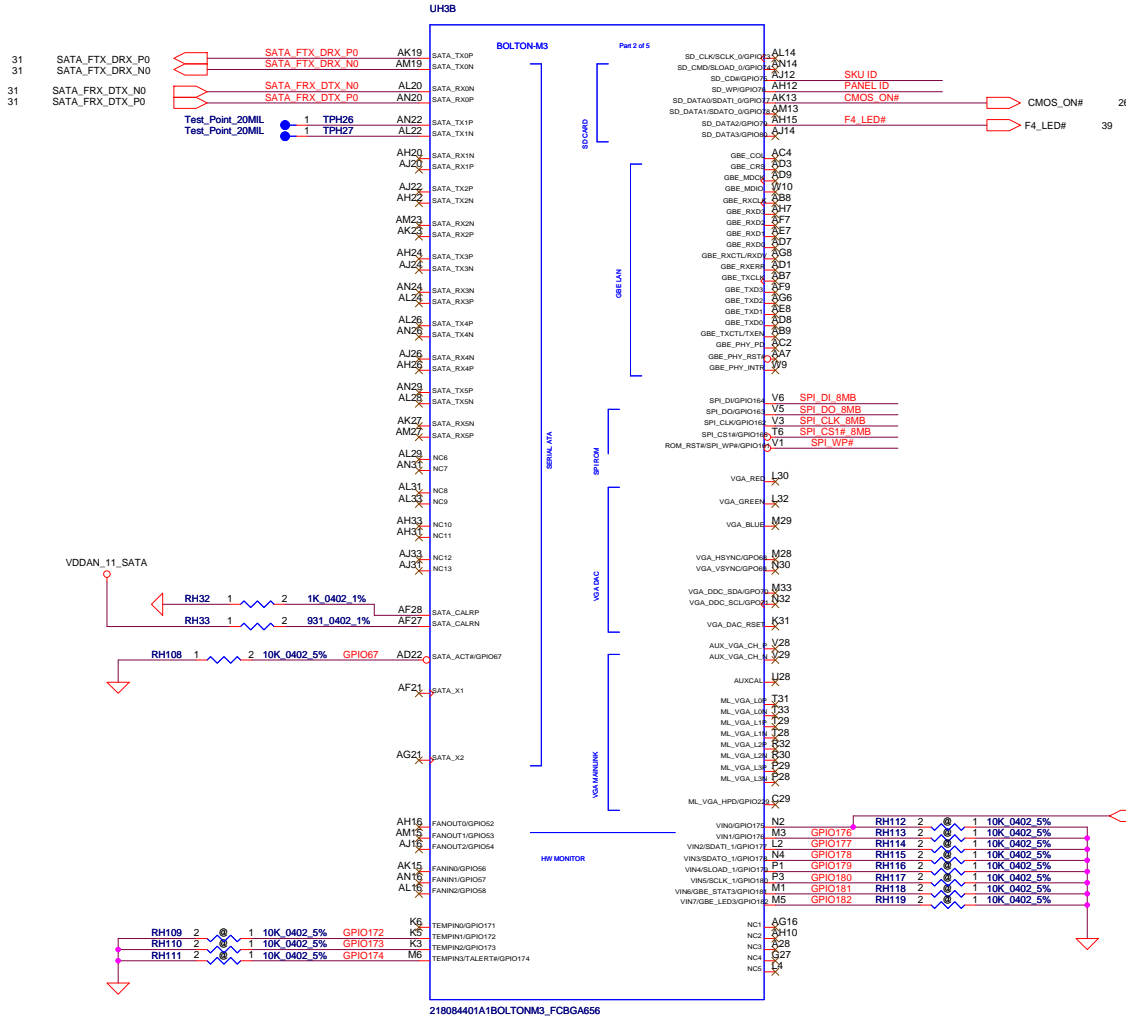
All VREF traces should have 20 mil trace width



For RF

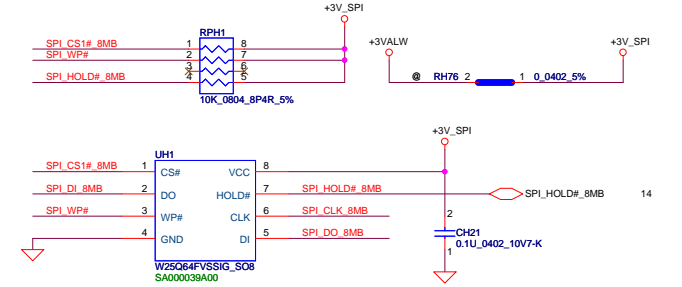
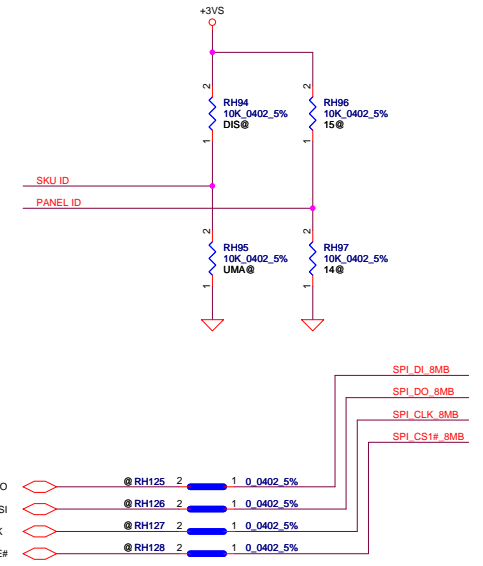
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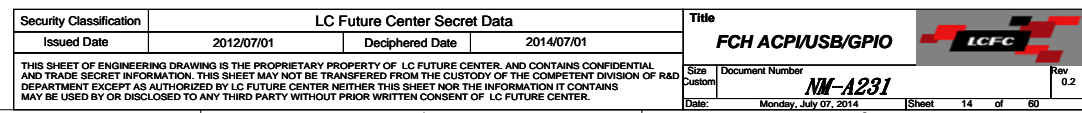


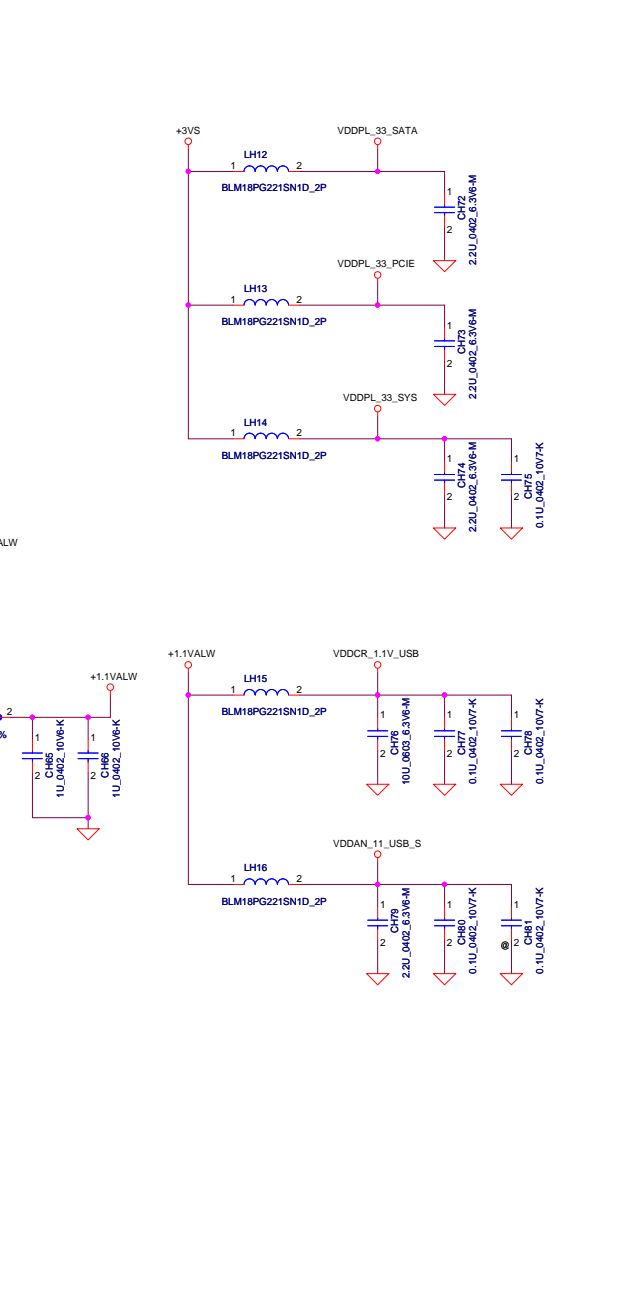
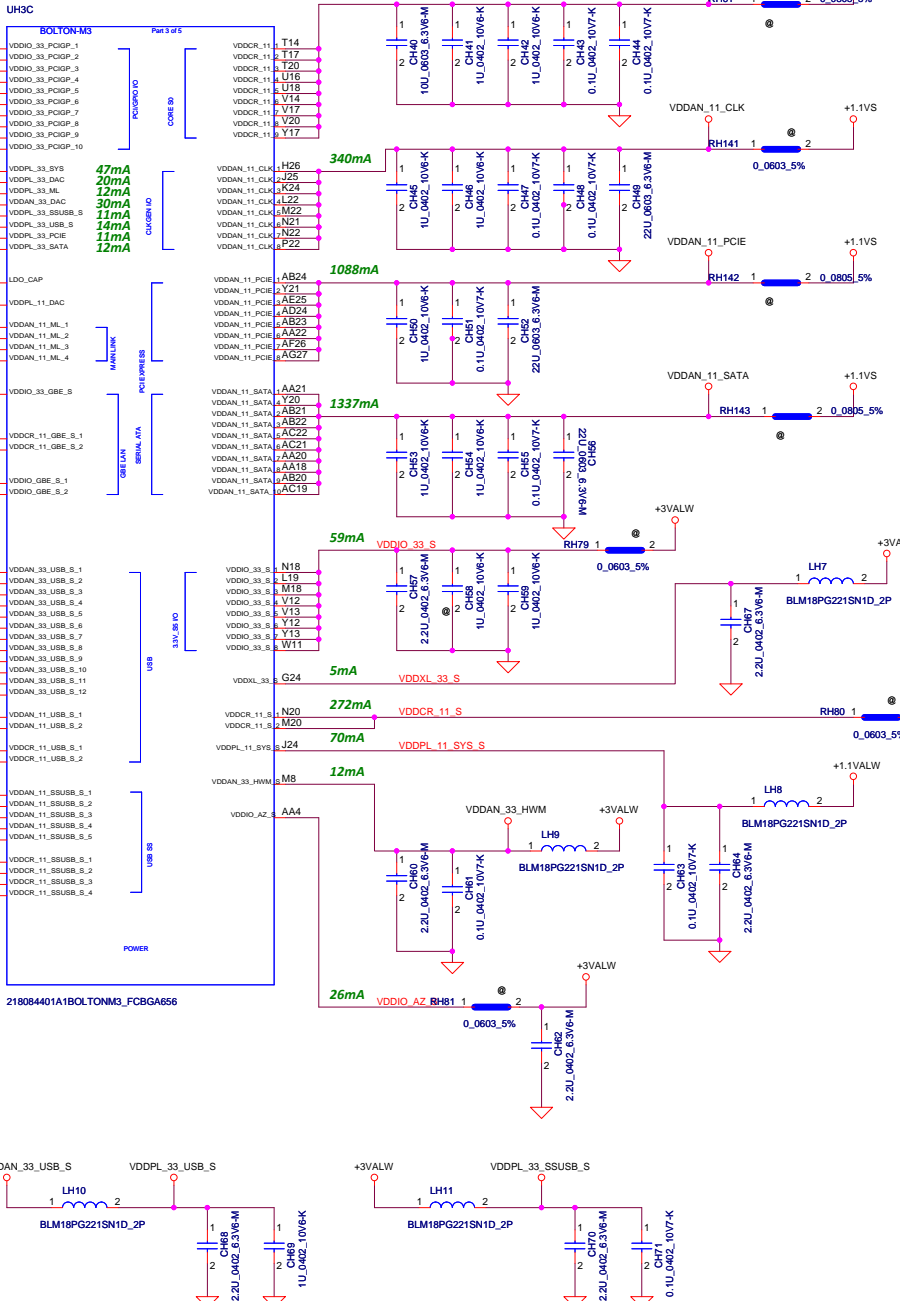



Table

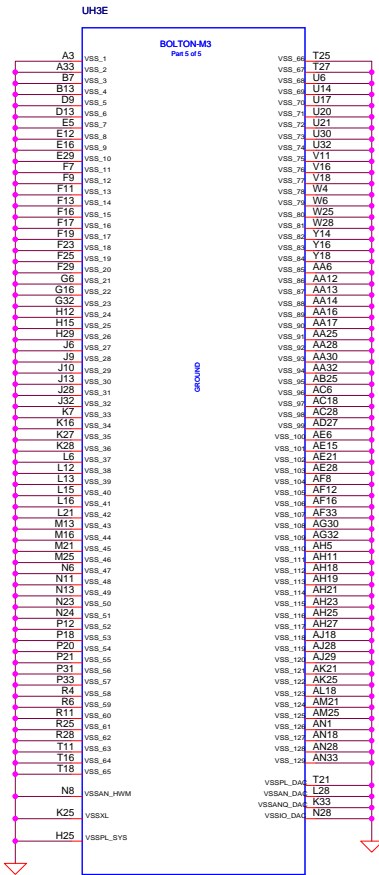
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* UMA	0	
* DIS	1	
* 14"		0
* 15"		1

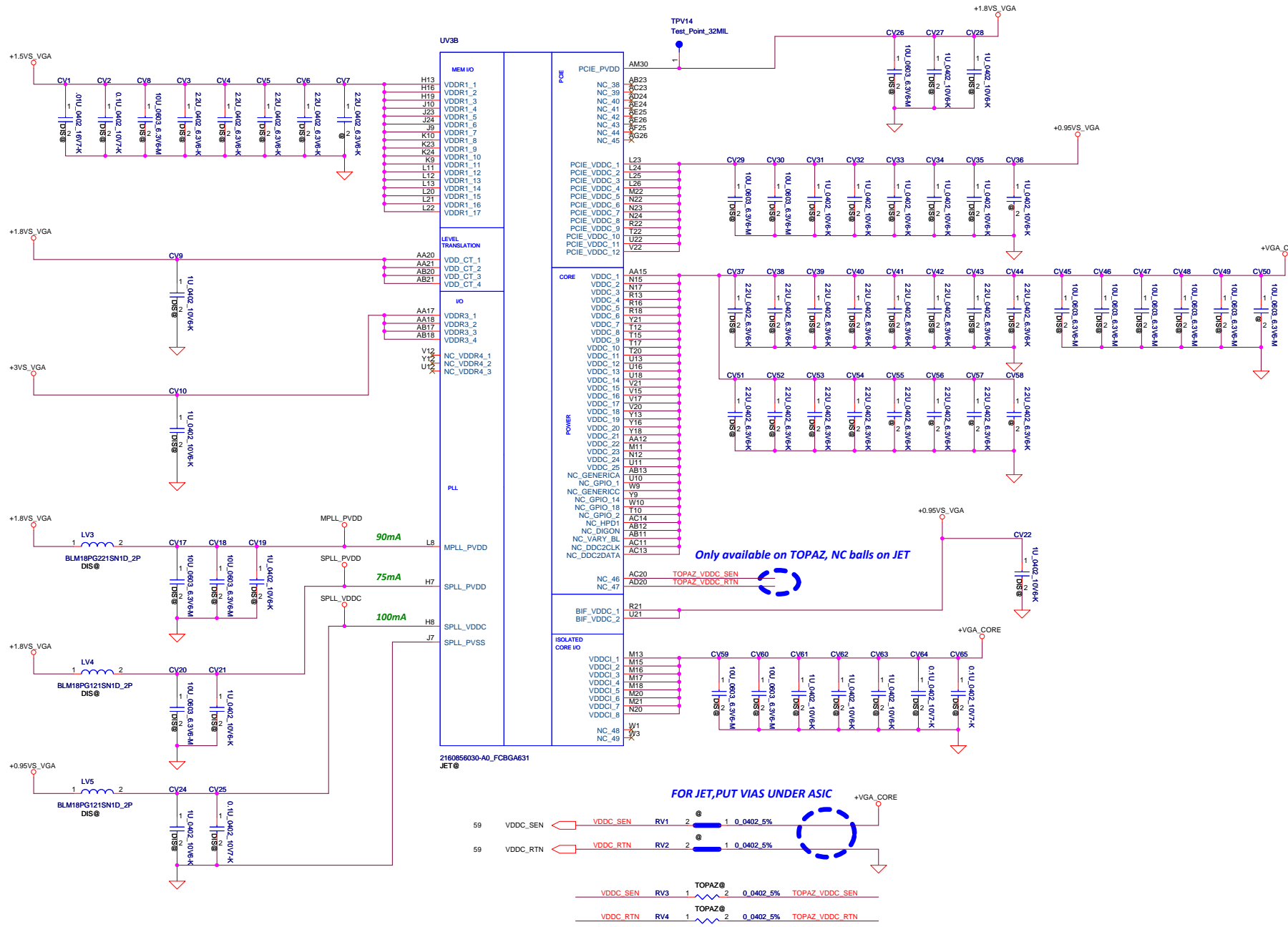




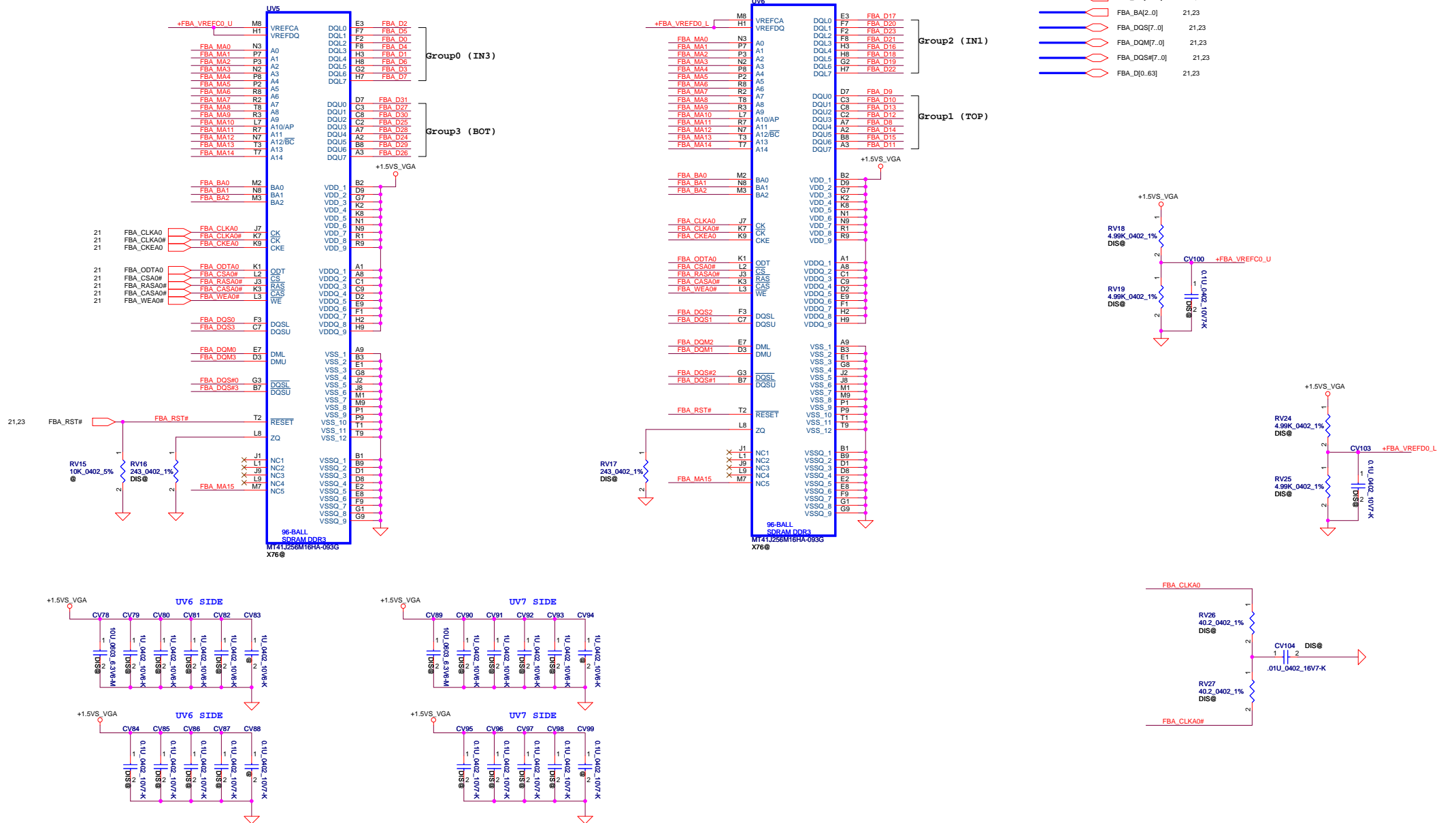



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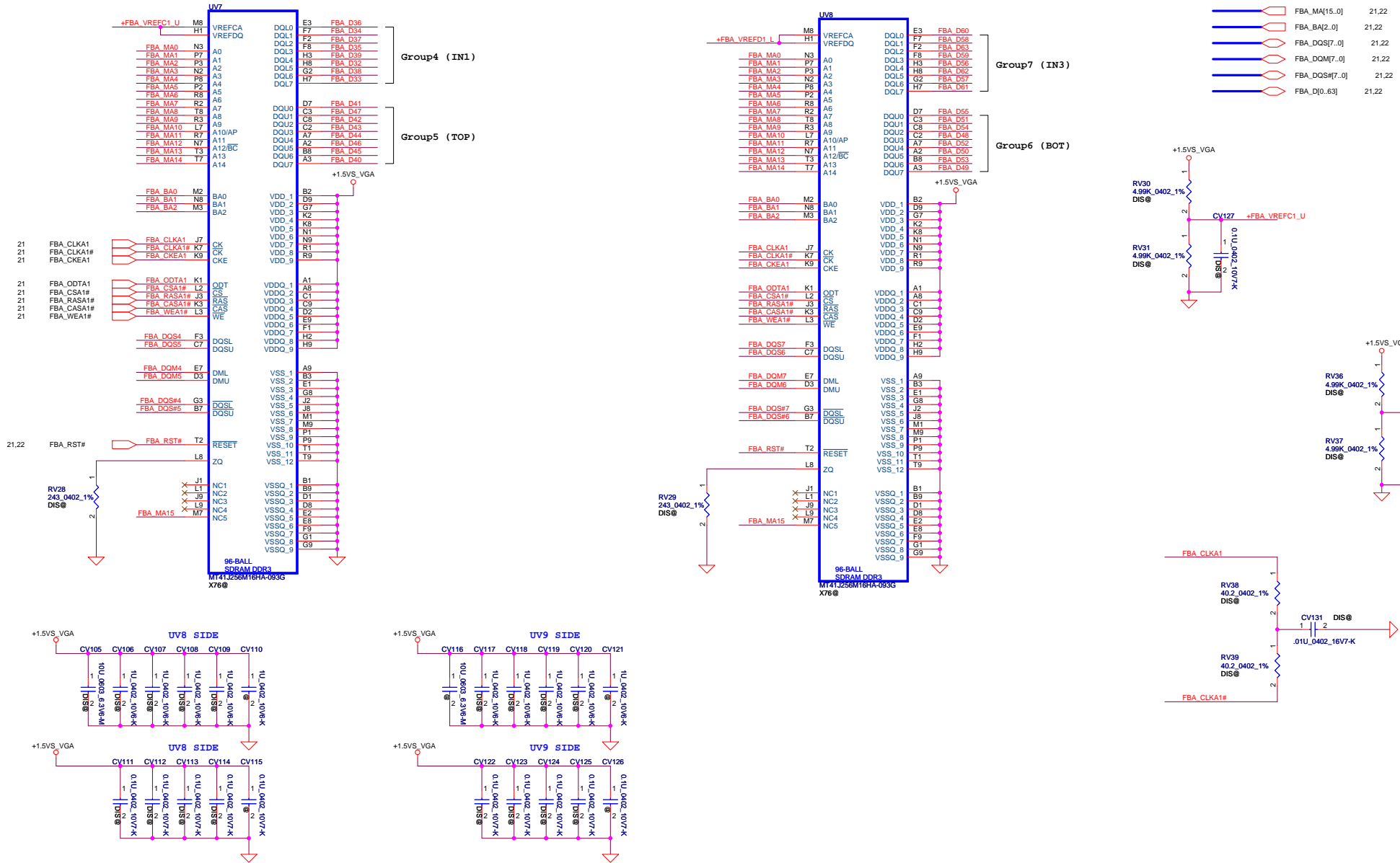


Memory Partition A - Lower 32 bits

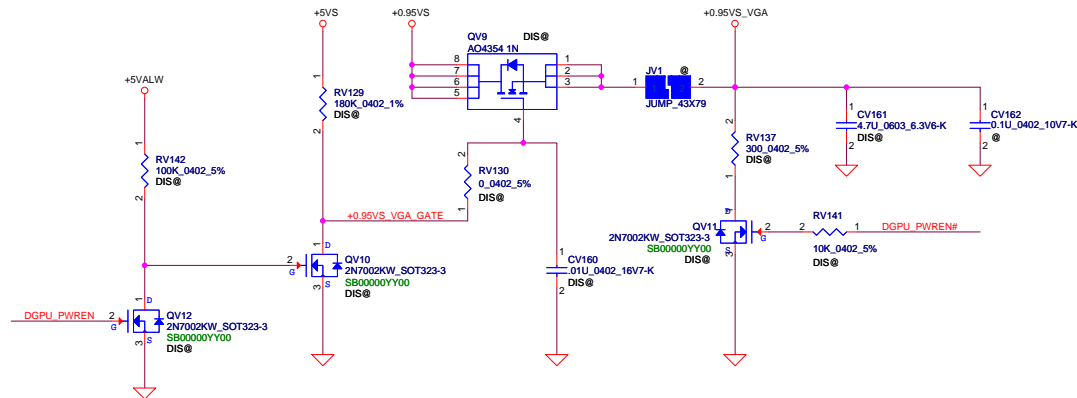


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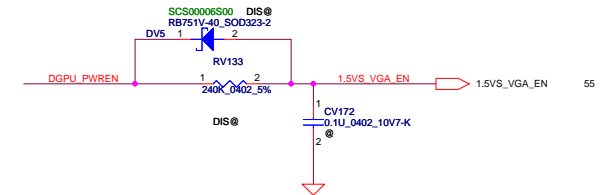
Memory Partition A - Upper 32 bits



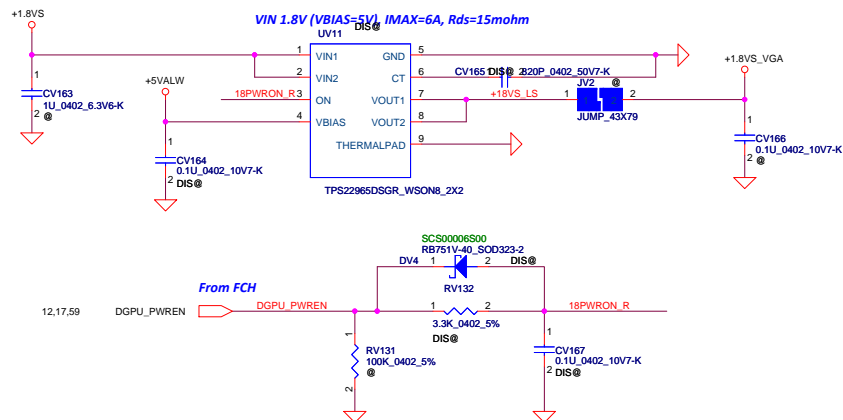
+0.95VS to +0.95VS_VGA



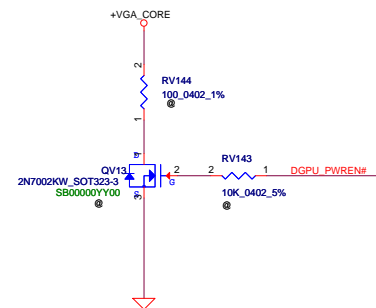
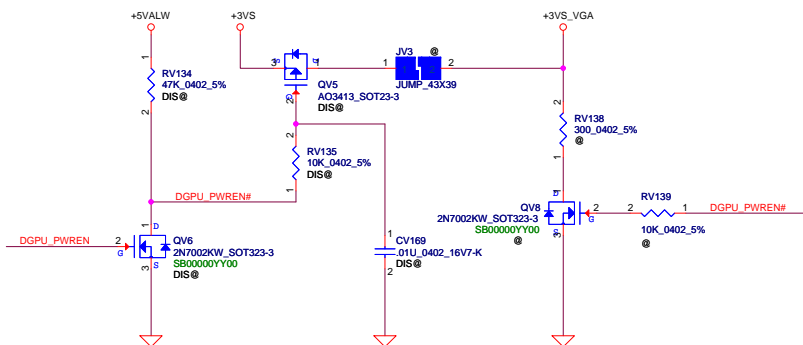
+1.5VS to +1.5VS_VGA



+1.8VS to +1.8VS_VGA



+3VS to +3VS_VGA



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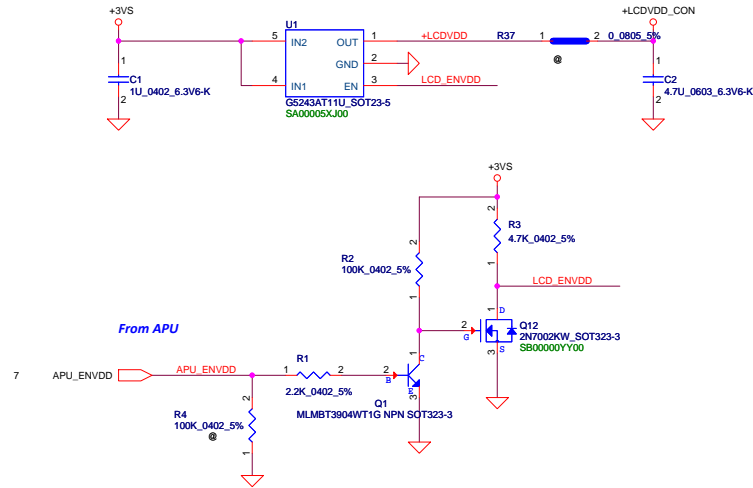
PS_0[1] PS_0[2] PS_0[3]	ROM_CONFIG[0] ROM_CONFIG[1] ROM_CONFIG[2]	STRAP_BIOS_ROM_EN = 1 ROM_CONFIG[2:0] = [001] 256MB
PS_0[4]	N/A	1 (Default)
PS_0[5]	N/A	1 (Default)
PS_1[1]	STRAP_BIF_GEN3_EN_A	0 = PCIe GEN3 is not supported
PS_1[2]	STRAP_BIF_CLK_PM_EN	0 = The CLKREQB power management capability is disabled
PS_1[3]	N/A	0 (Default)
PS_1[4]	STRAP_TX_CFG_DRV_FULL_SWING	1 = The transmitter full-swing is enabled
PS_1[5]	STRAP_TX_DEEMPH_EN	1 = Tx deemphasis enabled
PS_2[1]	N/A	0 (Default)
PS_2[2]	N/A	0 (Default)
PS_2[3]	STRAP_BIOS_ROM_EN	0 = Disable the external BIOS ROM device
PS_2[4]	N/A	1 (Default)
PS_2[5]	N/A	1 (Default)
PS_3[1] PS_3[2] PS_3[3]	BOARD_CONFIG[0] BOARD_CONFIG[1] BOARD_CONFIG[2]	PS_3[3..1] 101 = Micron 2G 110 = Samsung 2G 111 = Hynix 2G
PS_3[4]	N/A	1 (Default)
PS_3[5]	N/A	1 (Default)

MLPS	Bit				
	5	4	3	2	1
PS_0[5:1]	1	1	0	0	1
PS_1[5:1]	1	1	0	0	0
PS_2[5:1]	1	1	0	0	0
PS_3[5:1]	1	1	X	X	X

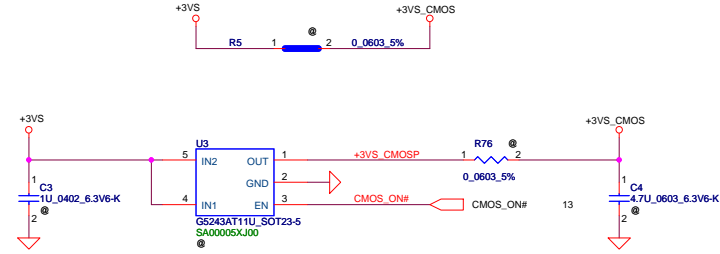
	PS_0		PS_1		PS_2		PS_3	
	RV98	RV99	RV102	RV103	RV100	RV101	RV104	RV105
Micron 2G	PU 8.45K	PD 2K	NC	PD 4.75K	NC	PD 4.75K	PU 3.24K	PD 5.62K
Samsung 2G	PU 8.45K	PD 2K	NC	PD 4.75K	NC	PD 4.75K	PU 3.4K	PD 10K
Hynix 2G	PU 8.45K	PD 2K	NC	PD 4.75K	NC	PD 4.75K	PU 4.75K	NC

3.24K SD03432418T
5.62K SD03456210T
3.4K SD03434010T

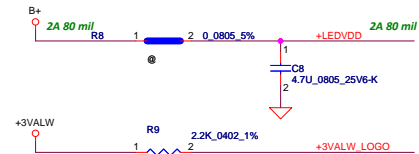
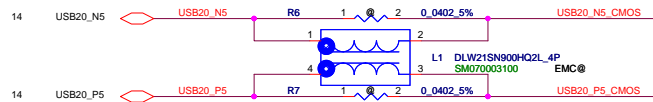
LCDVDD Circuit



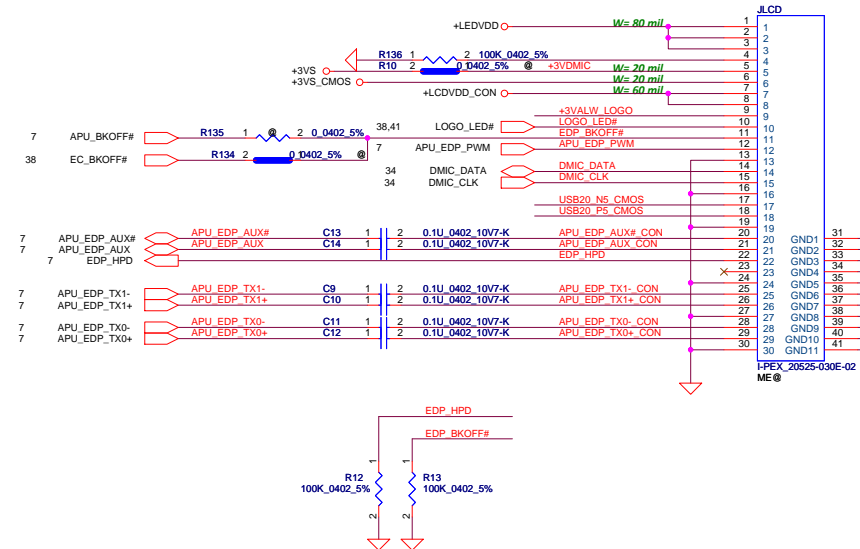
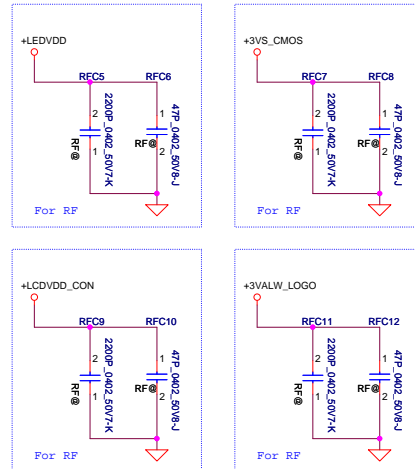
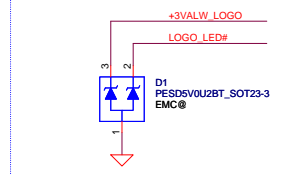
CMOS Camera



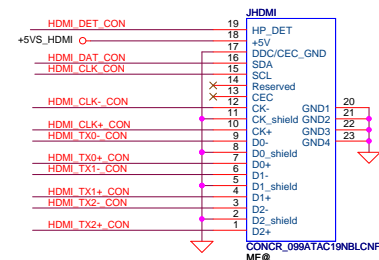
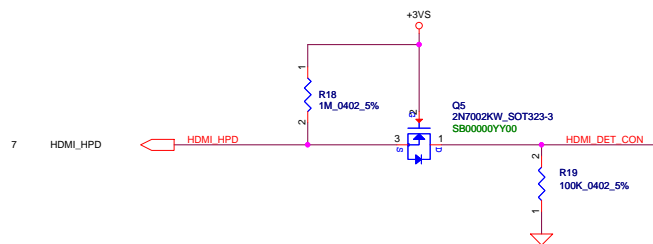
CMOS USB Port5



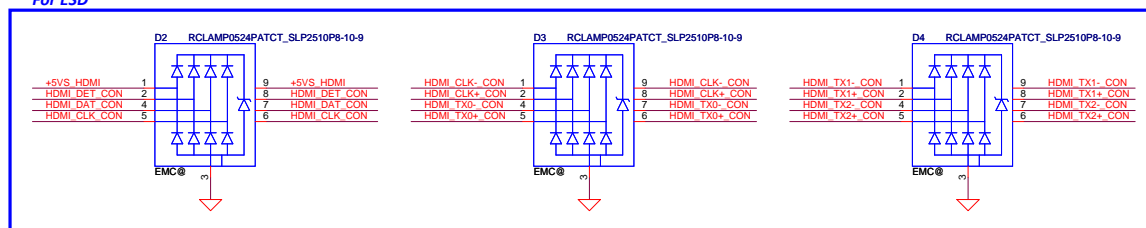
ESD request

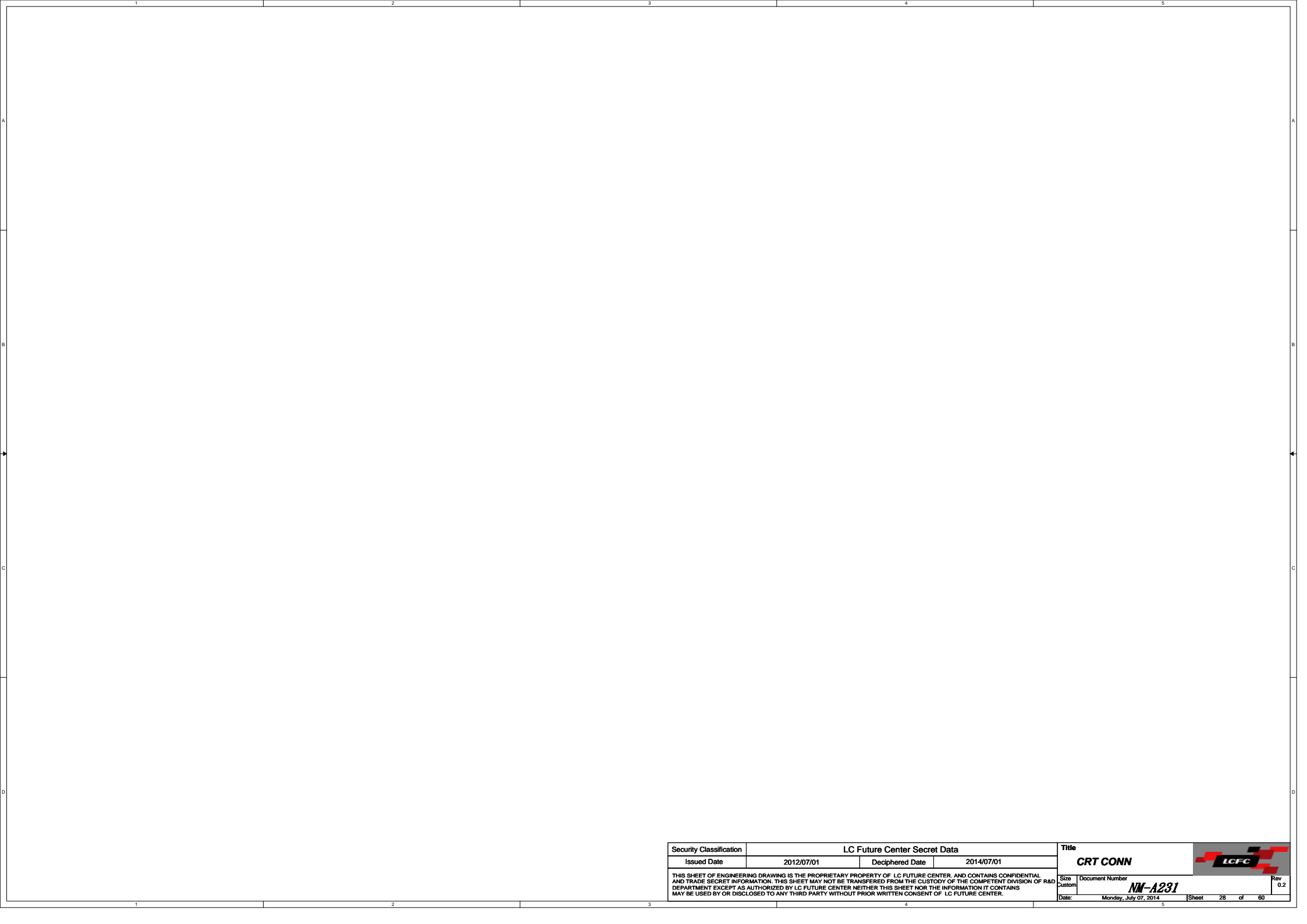



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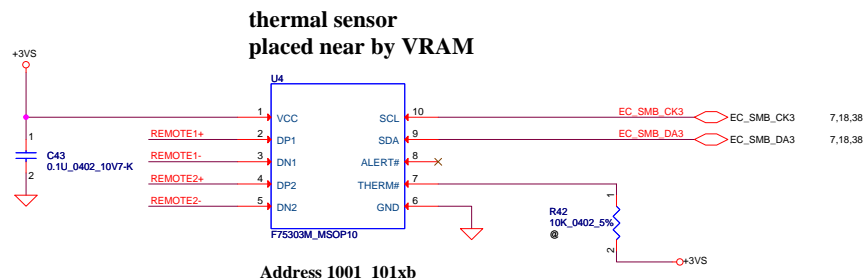
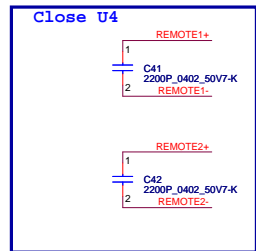


For ESD



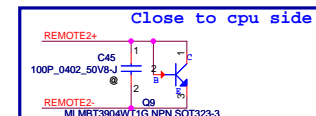
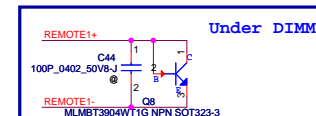


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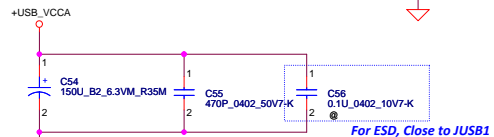
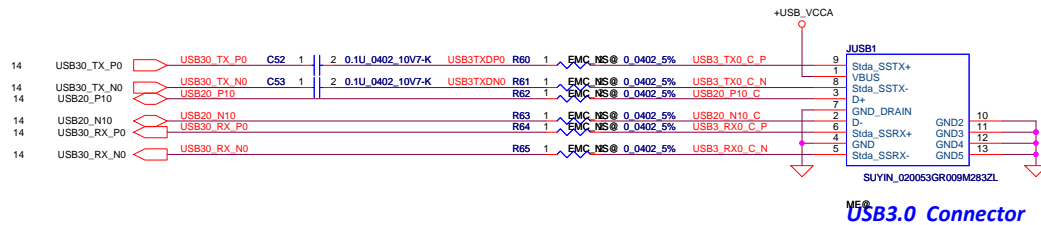
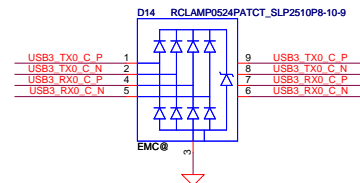
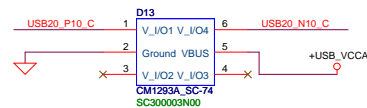
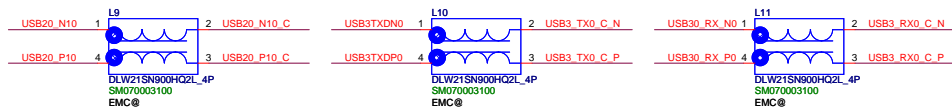
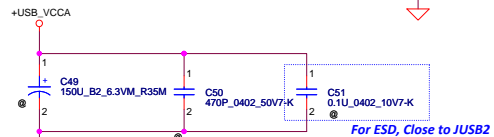
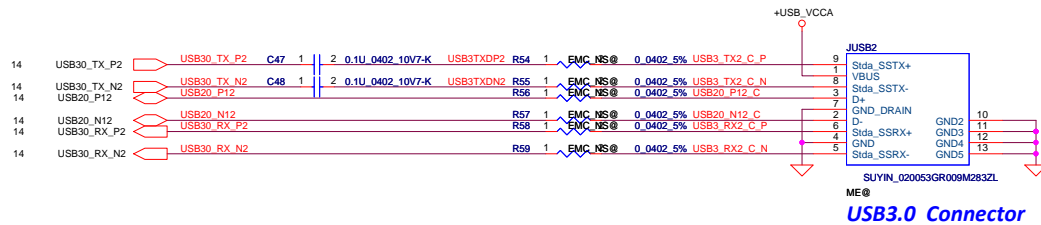
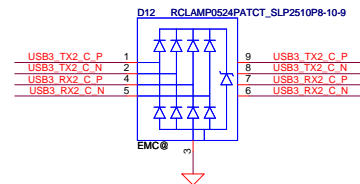
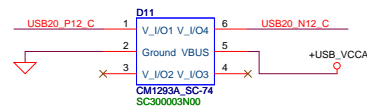
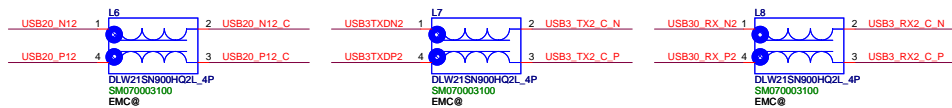
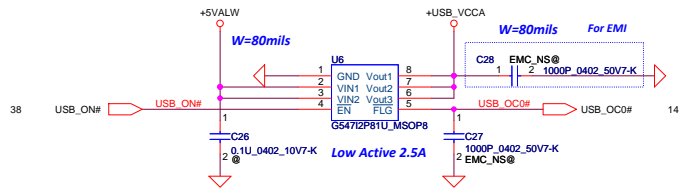


Address 1001_101xb

internal pull up 1.2K to 1.5V
R for initial thermal
shutdown temp



REMOTE2+/-:
Trace width/space:10/10 mil
Trace length:<8"




For ESD, Close to JUSB2

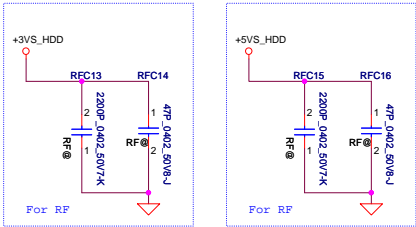
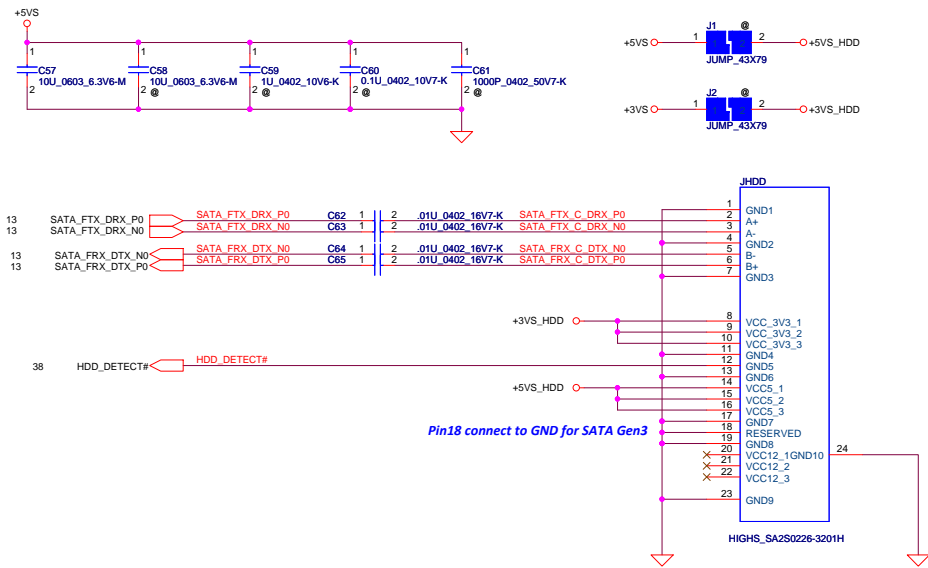
For ESD, Close to JUSB1

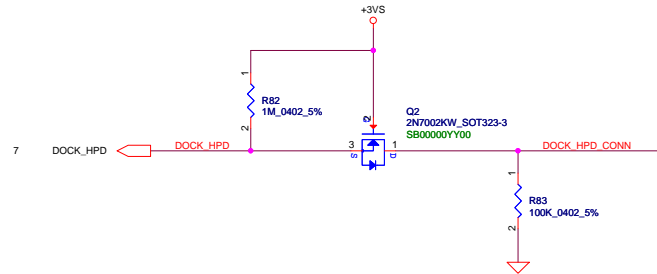
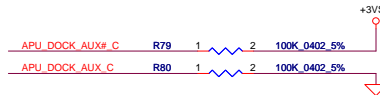
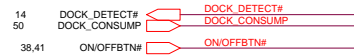
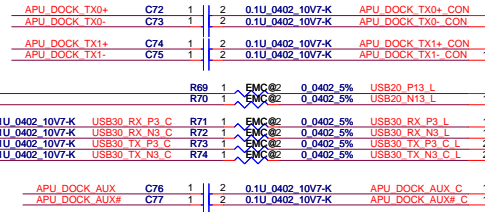
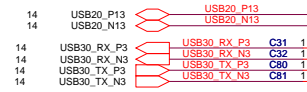
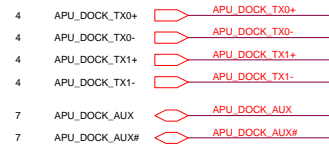
USB3.0 Connector

USB3.0 Connector

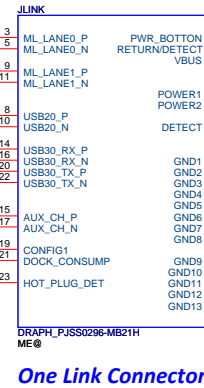
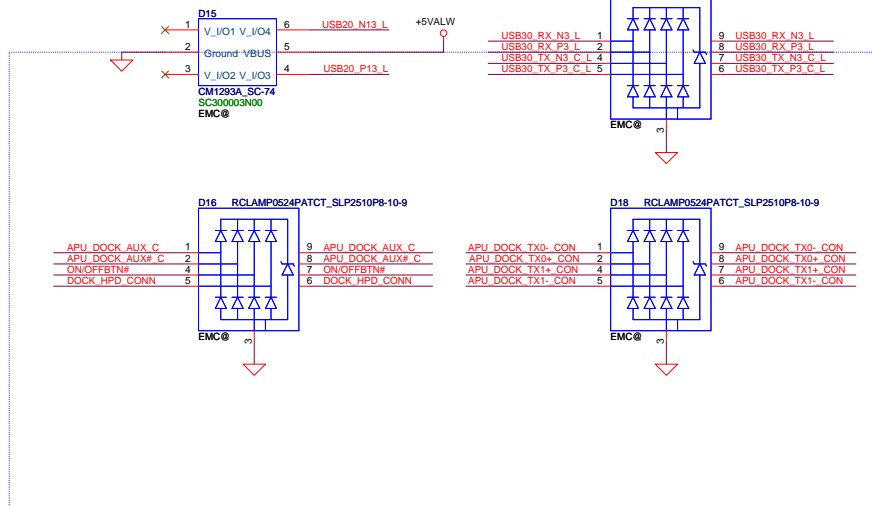
Security Classification		LC Future Center Secret Data			Title		
Issued Date		2012/07/01	Deciphered Date	2014/07/01	USB CONN		
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				NM-A231		0.2	
Date:		Monday, July 07, 2014			Sheet		30 of 60

SATA HDD



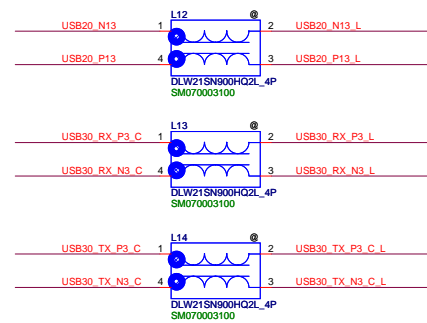



ESD(Close to connector)



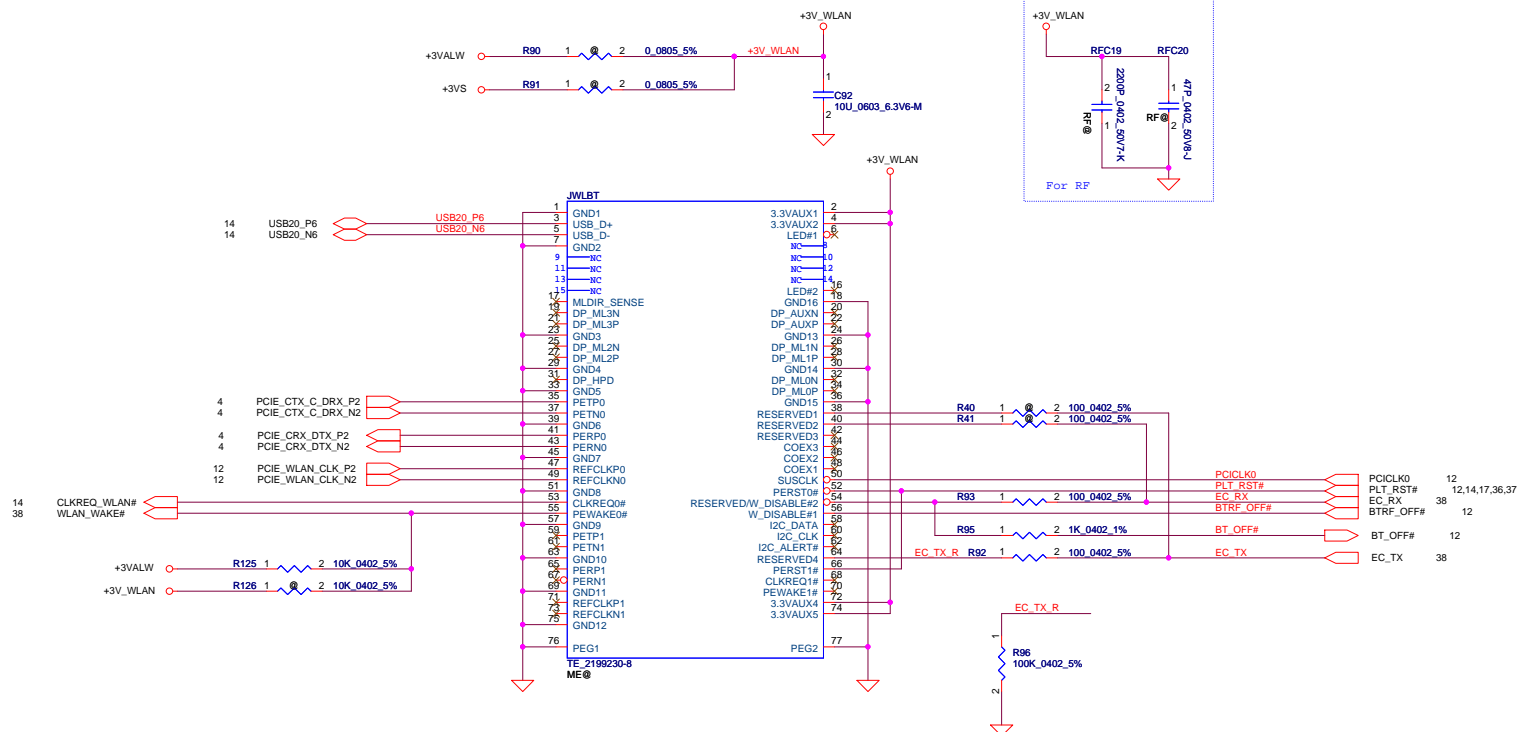
One Link Connector

EMI



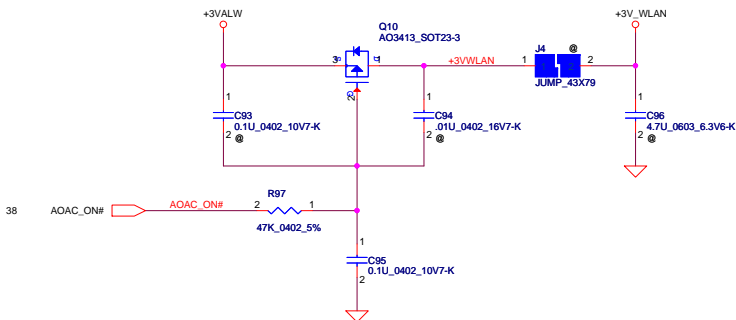
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2012/12/7		2014/12/7				
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Size		Document Number		Rev		
Custom		NM-A231		0.2		
Date:		Monday, July 07, 2014		Sheet 32 of 60		

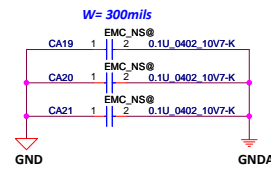
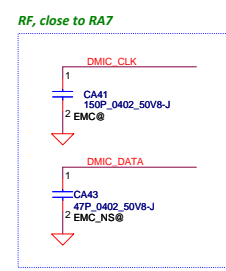
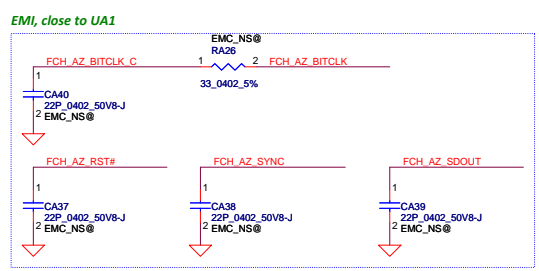
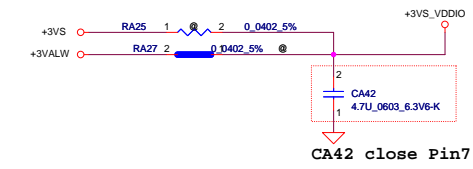
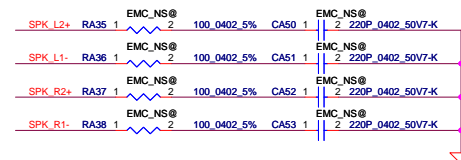
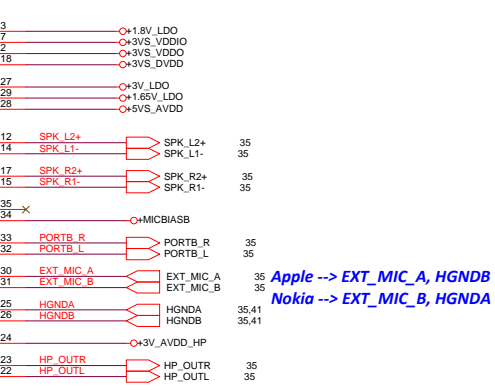
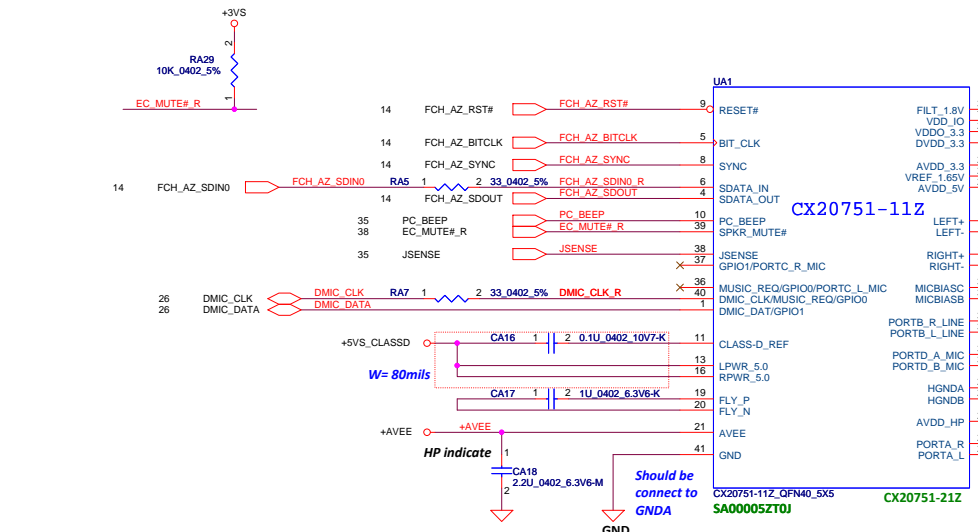
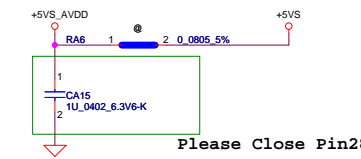
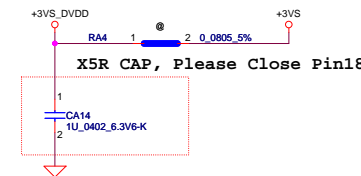
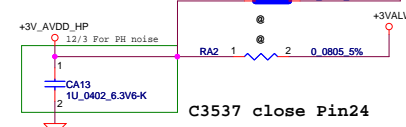
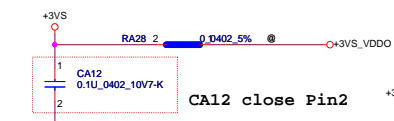
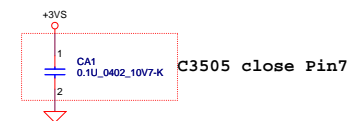
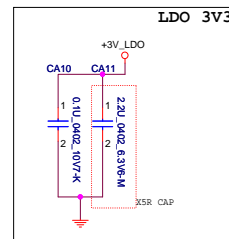
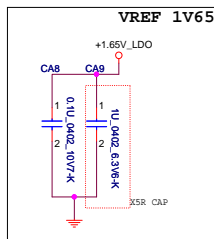
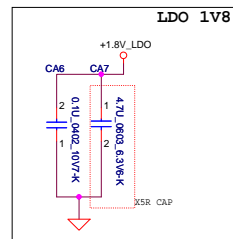
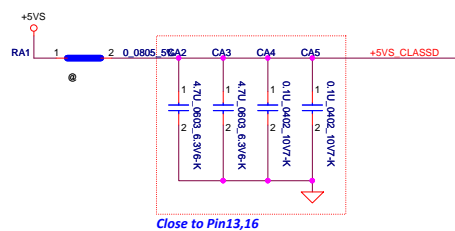
NGFF typeA Card(WLAN)



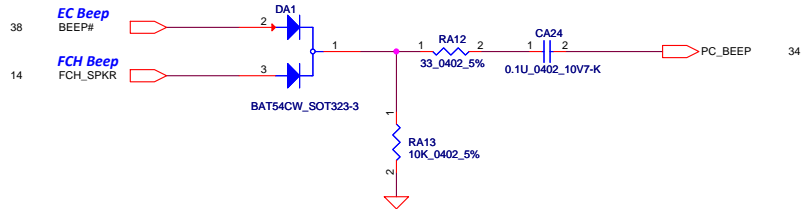
- 1. softstart (RC) will check on EVT PCB
- 2. if AOAC enable +3V_WLAN always ON
- if AOAC disable +3V_WLAN is same as +3V_S

+3VALW to +3V_WLAN

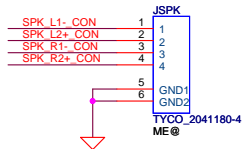
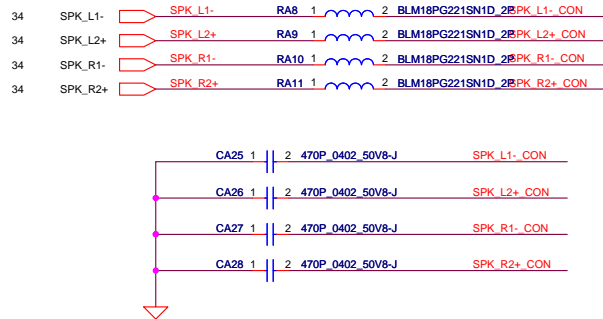




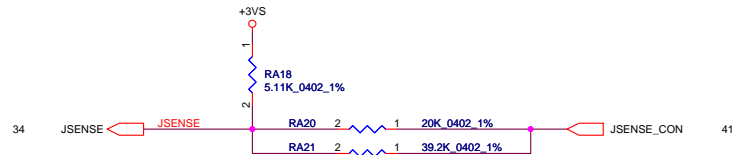
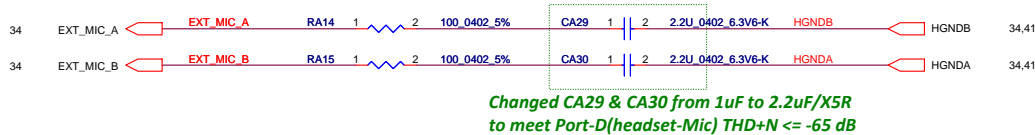
PC BEEP



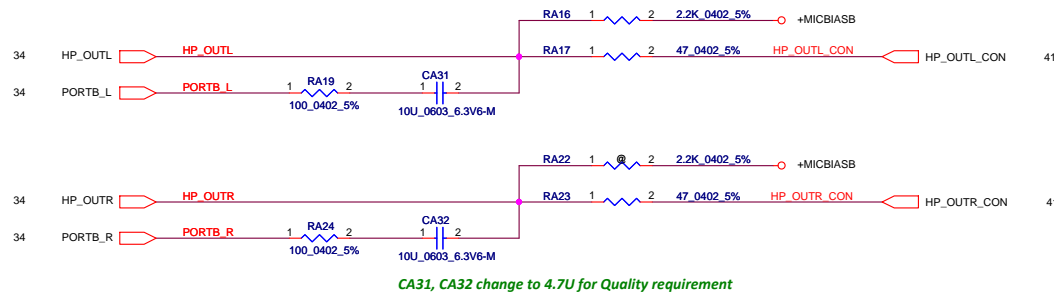
Speaker

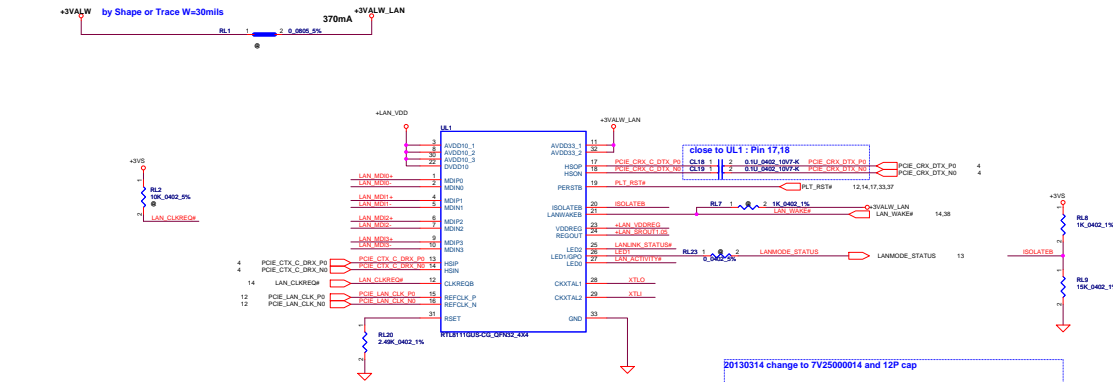


EXT. MIC/LINE IN Apple --> EXT_MIC_A, HGND B
Nokia --> EXT_MIC_B, HGND A

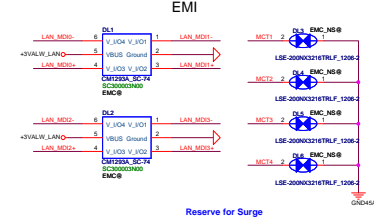
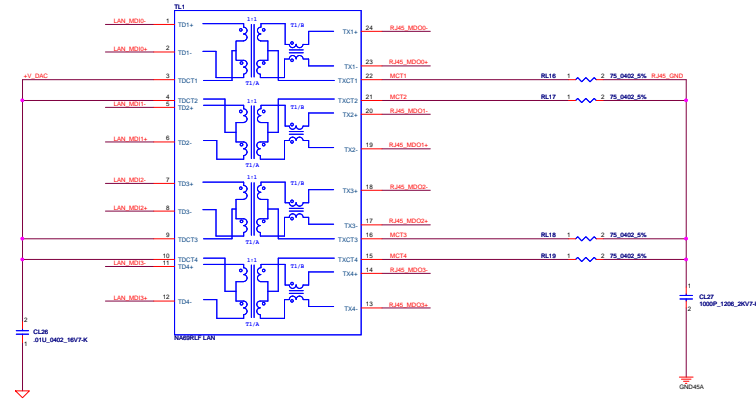
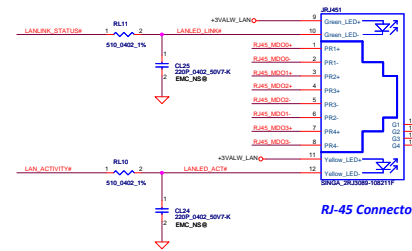
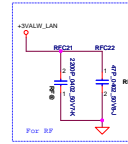
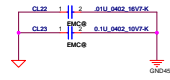
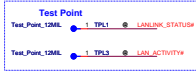
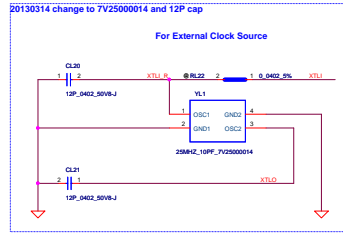
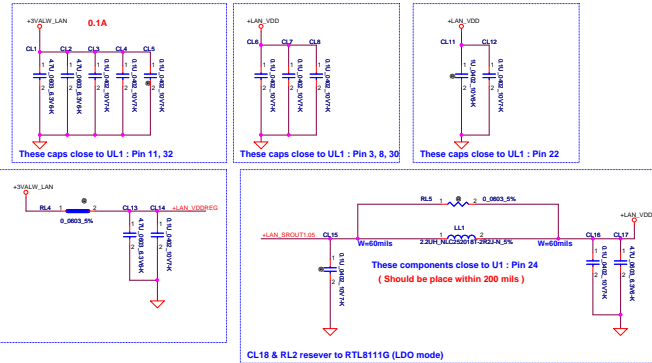


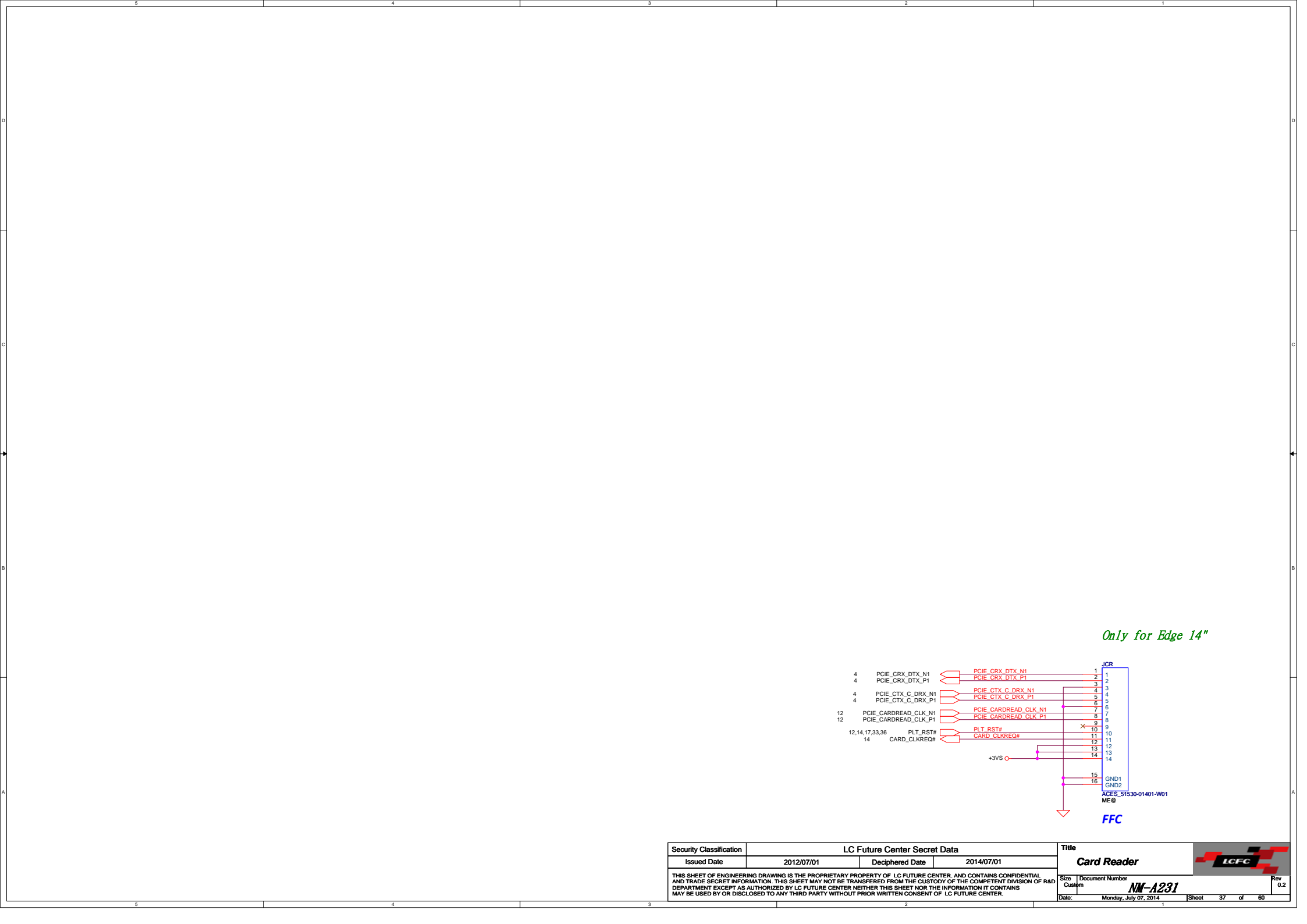
HeadPhone/LINE OUT

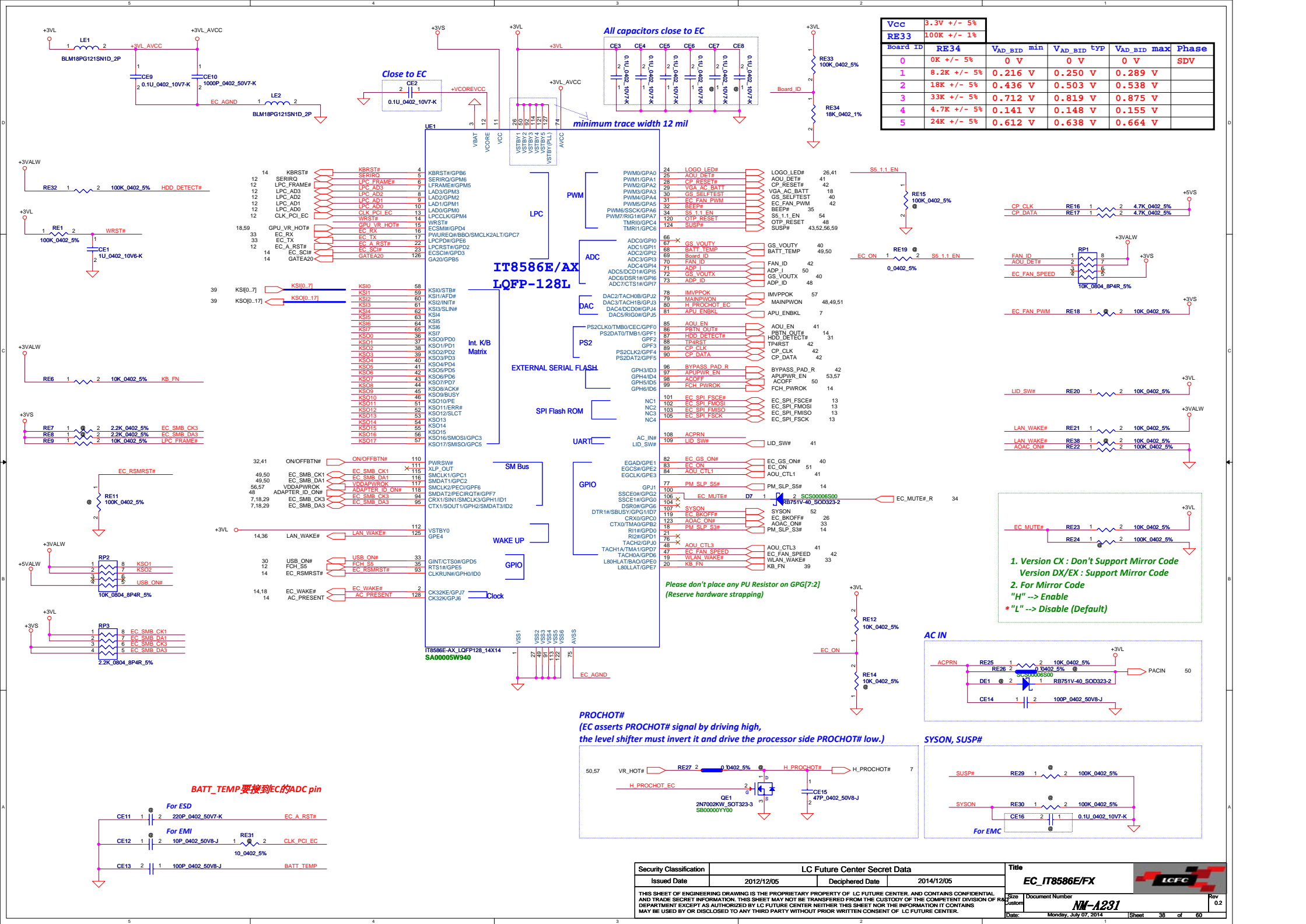




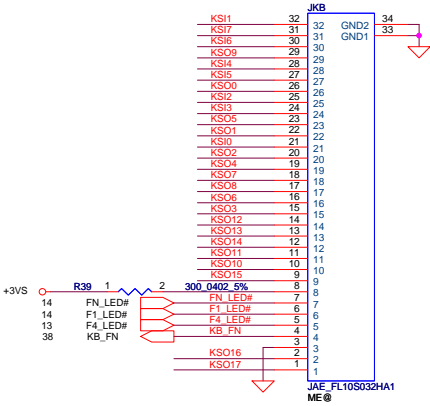
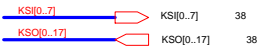
+3VALW_LAN Rising time (10%~90%) >1ms and <100mS



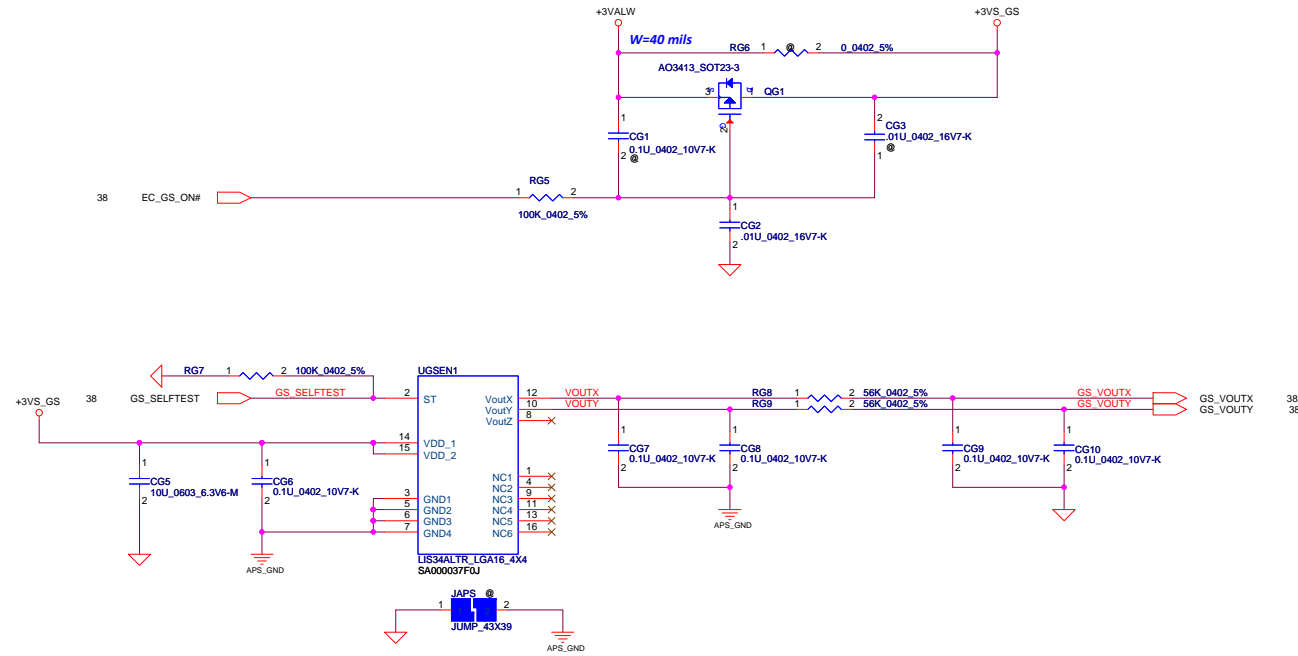


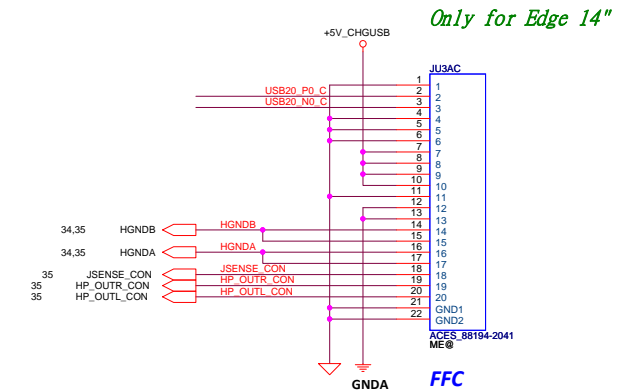
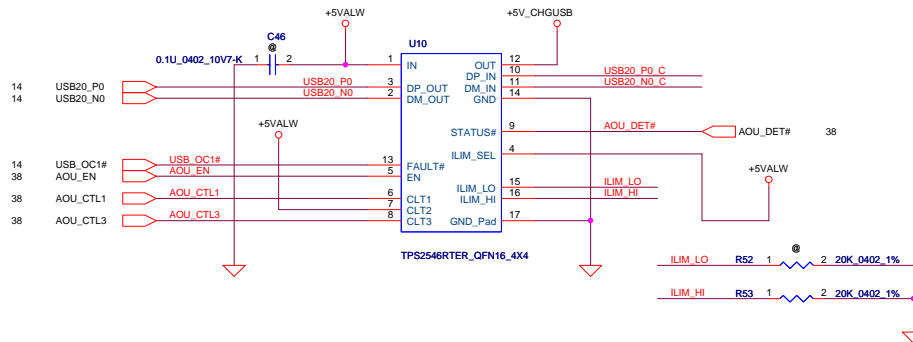


KeyBoard CONN.(14")



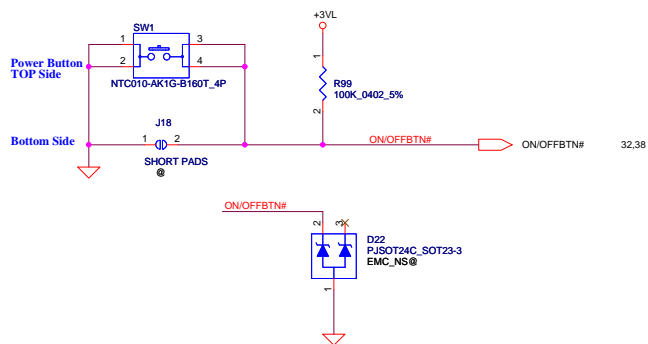
APS G-Sensor





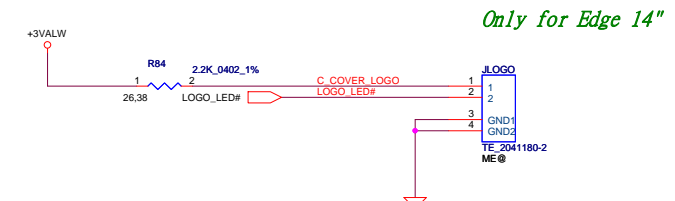
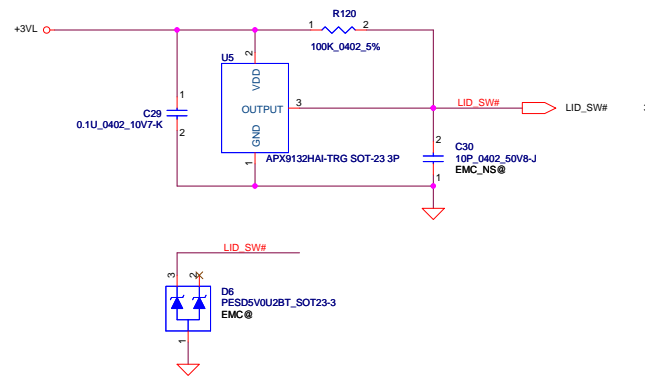
Power Button


ON/OFF switch



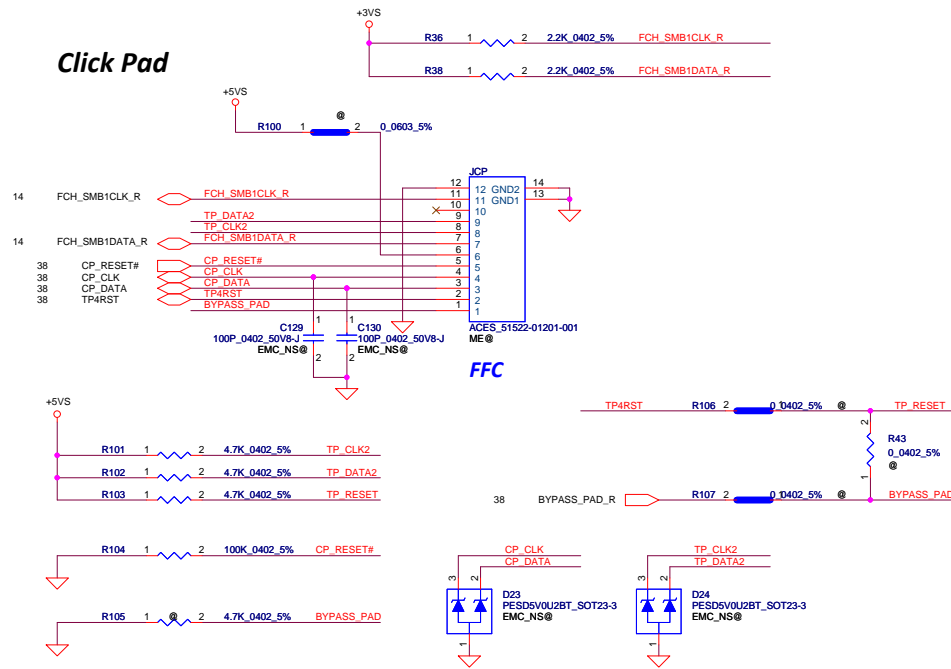
Only for Edge 14"

Lid Switch

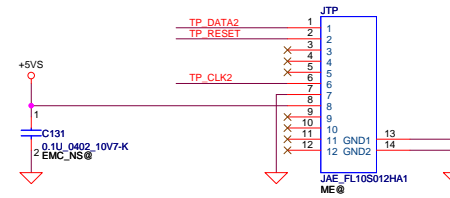


Security Classification		LC Future Center Secret Data		Title		
Issued Date	2012/12/05	Deciphered Date	2014/12/05	Sub-board/Power Button		
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				Date: Monday, July 07, 2014	Sheet 41	of 60

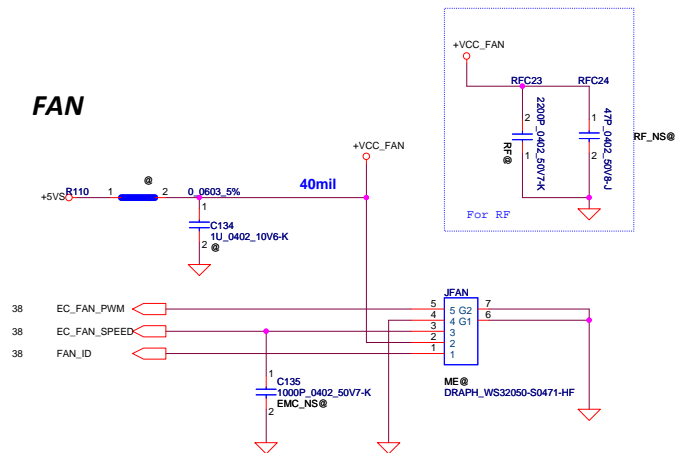
Click Pad



Track point



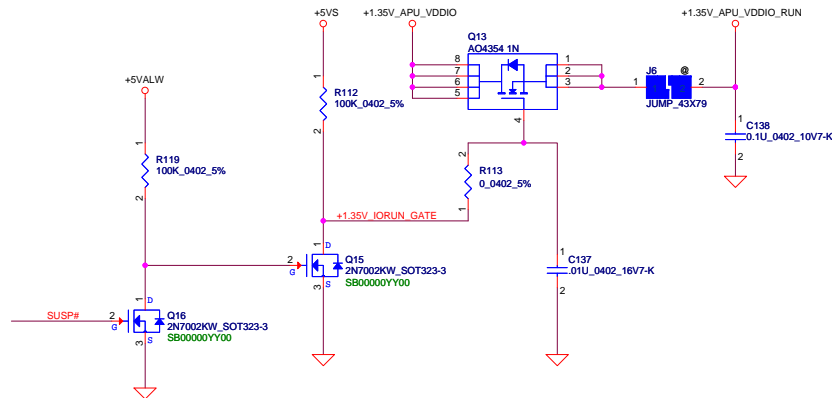
FAN



FingerPrint

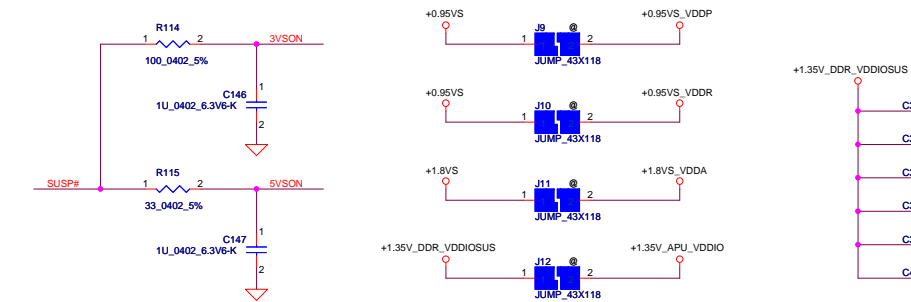
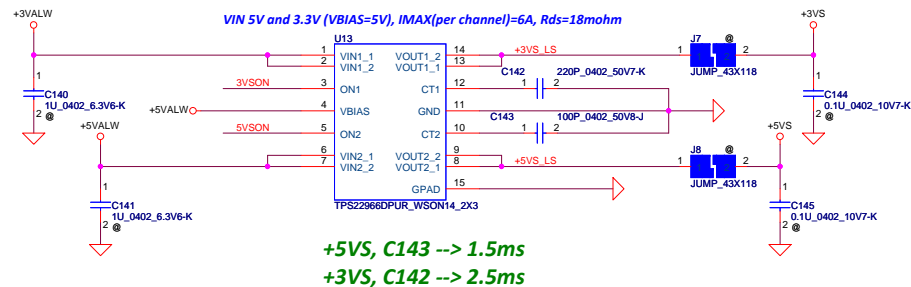
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				NM-A231	
				Date: Monday, July 07, 2014	Rev 0.2
				Sheet 42 of 60	

+VDDIO to +VDDIO_RUN

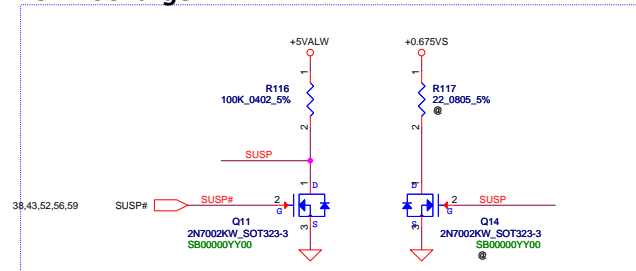


+5VALW To +5VS

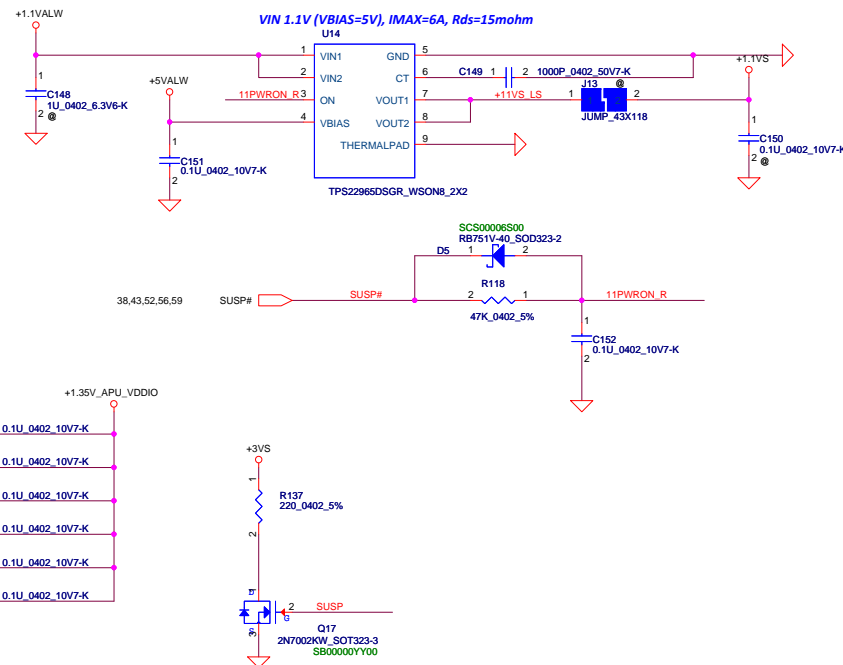
+3VALW To +3VS



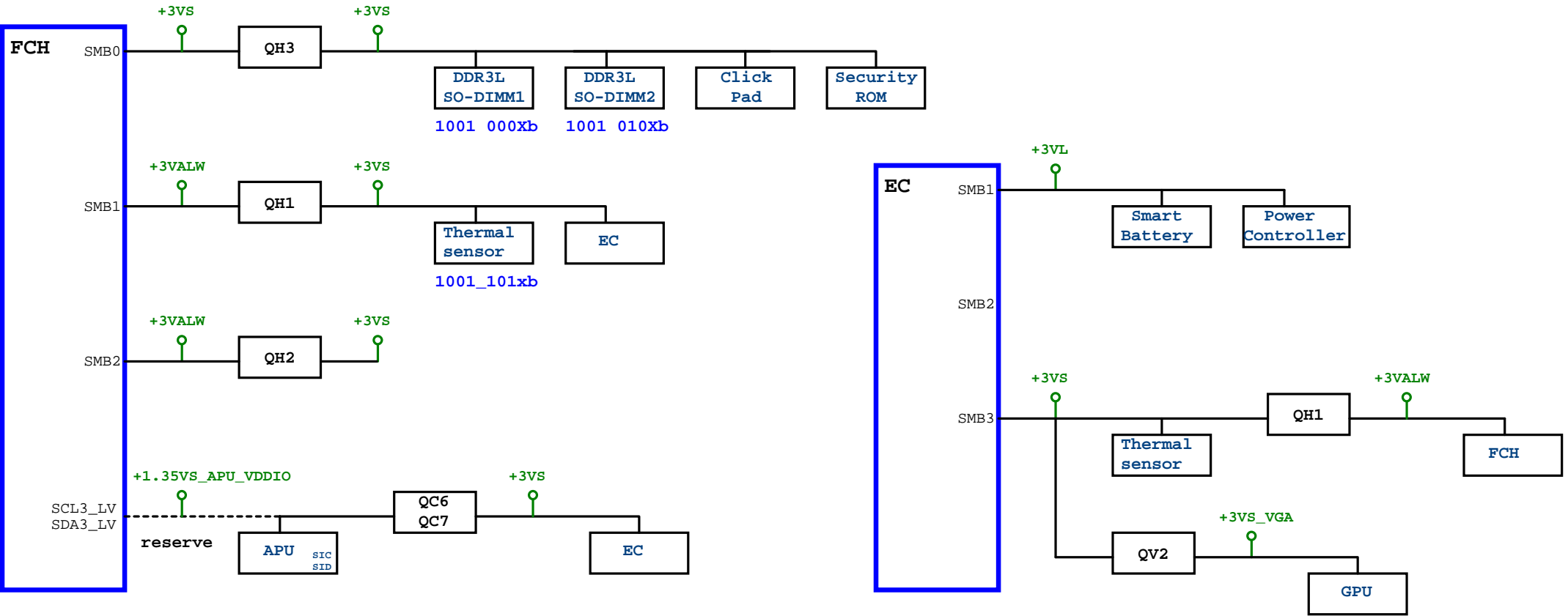
For DisCharge

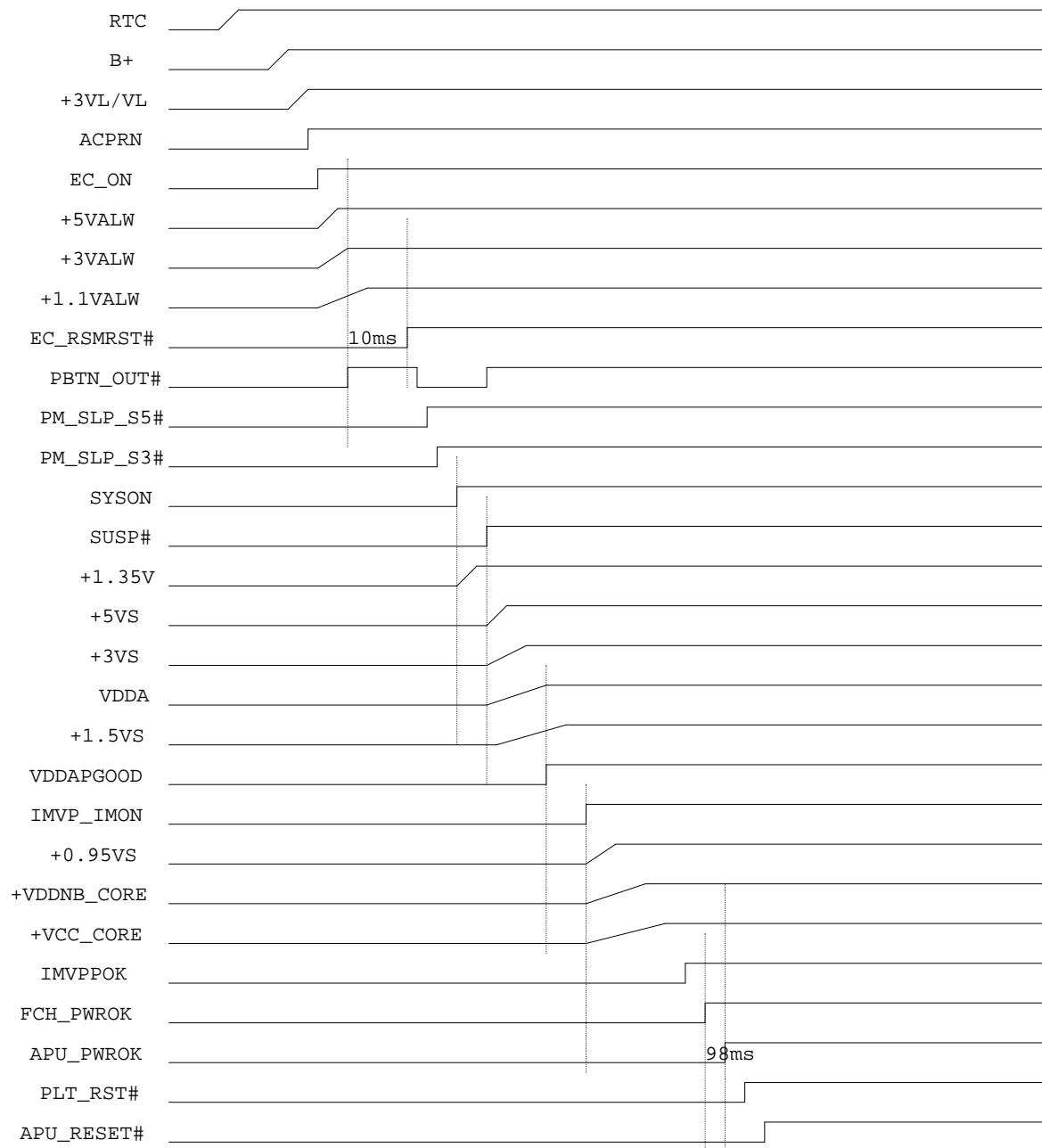


+1.1VALW to +1.1VS

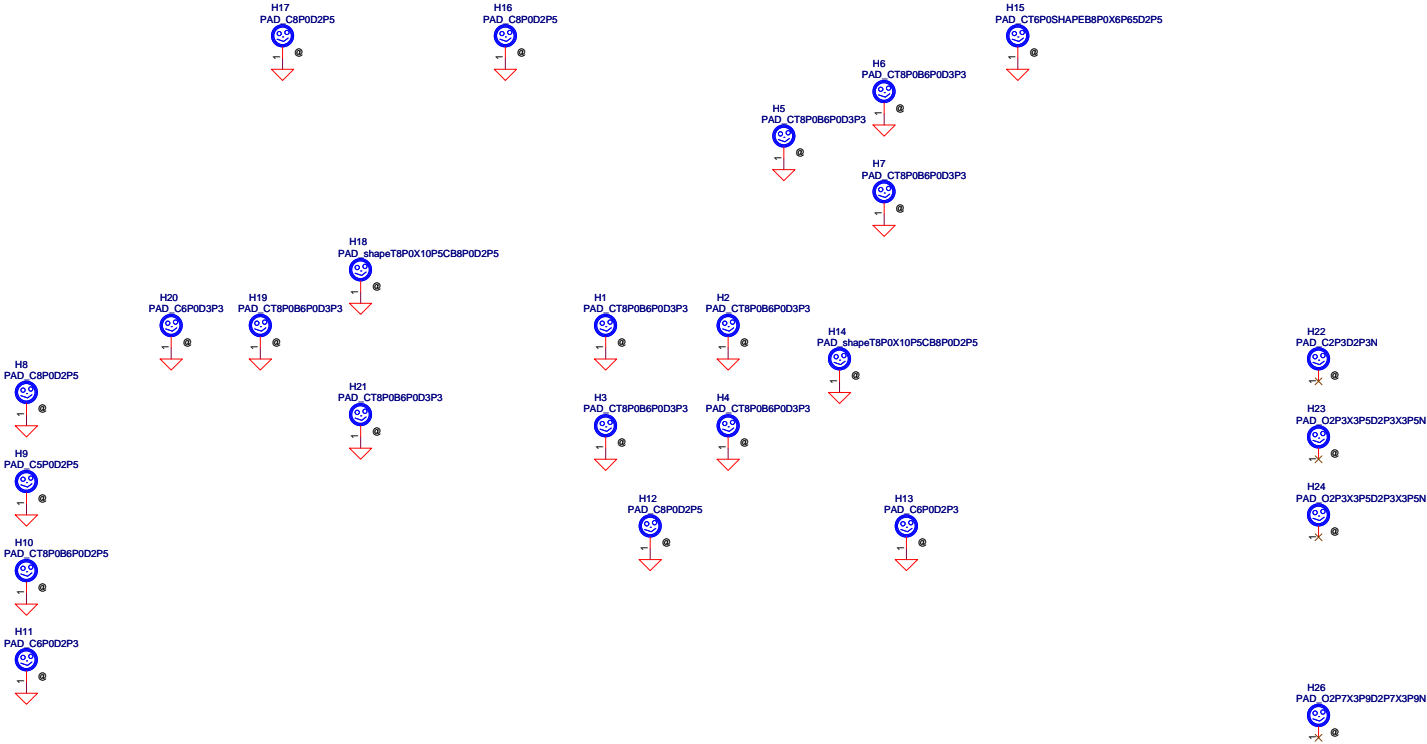


SMBus block diagram






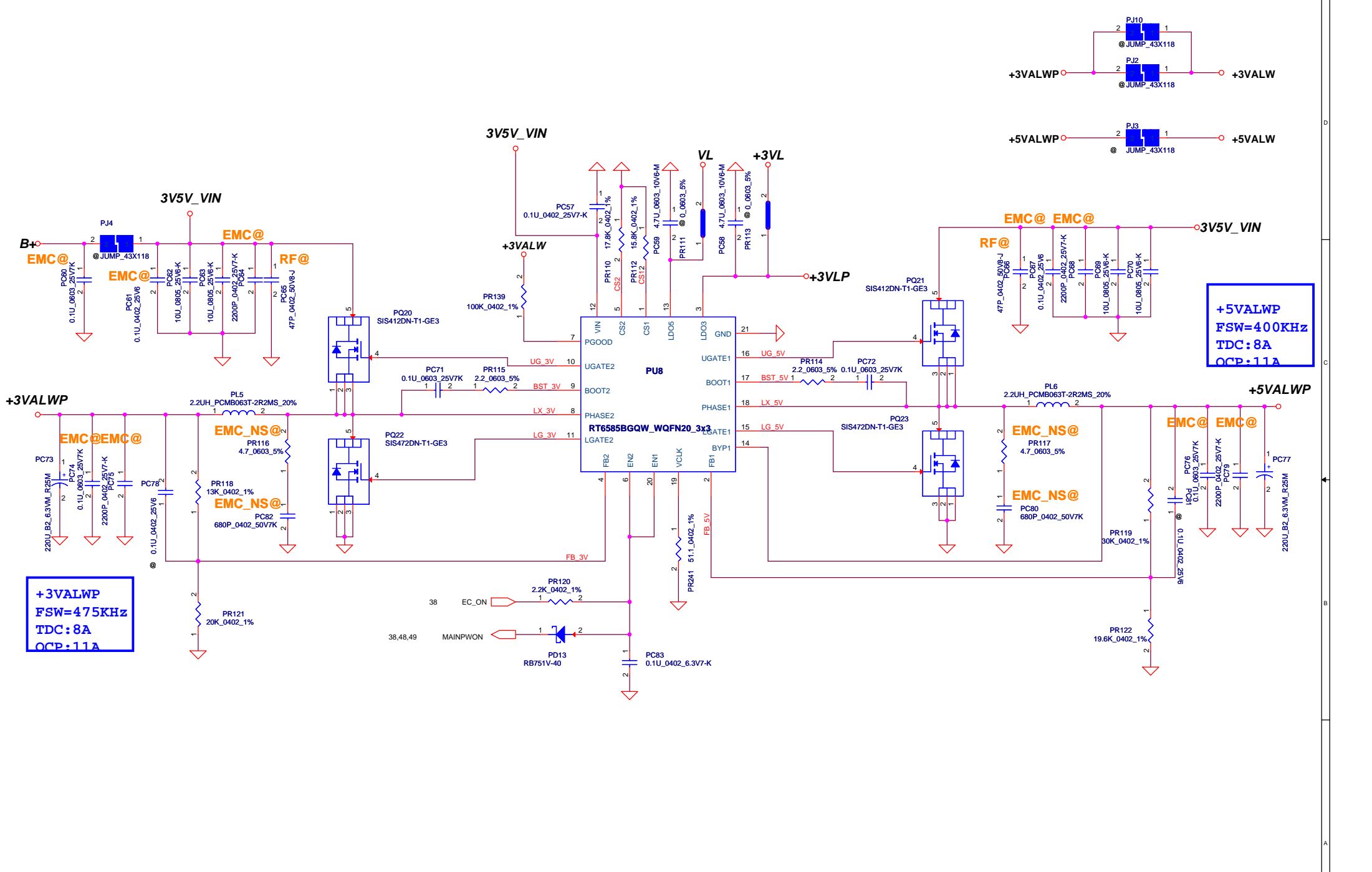
Only for Edge 14" SCREW LOCATION



PCB Federal Mark PAD



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Issued Date		2012/07/01		Deciphered Date				2014/07/01			
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				Custom		NM-A231		0.2			
				Date:		Monday, July 07, 2014		Sheet		47 of 60	



+3VALWP
FSW=475KHz
TDC:8A
OCP:11A

+5VALWP
FSW=400KHz
TDC:8A
OCP:11A

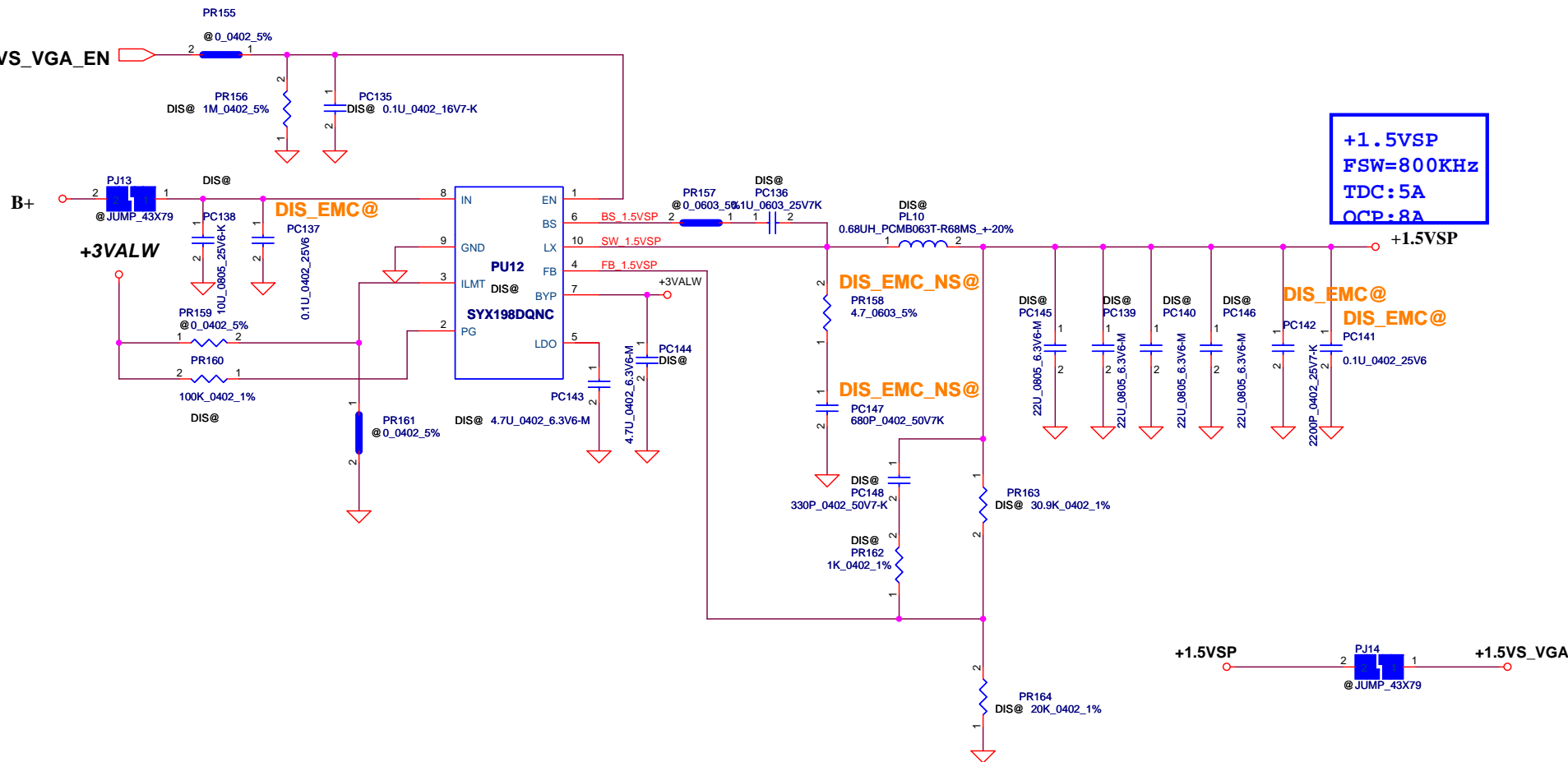
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Title		Size	
3VALWP/5VALWP		Custom	Document Number
Date: Monday, July 07, 2014		Rev 0.2	
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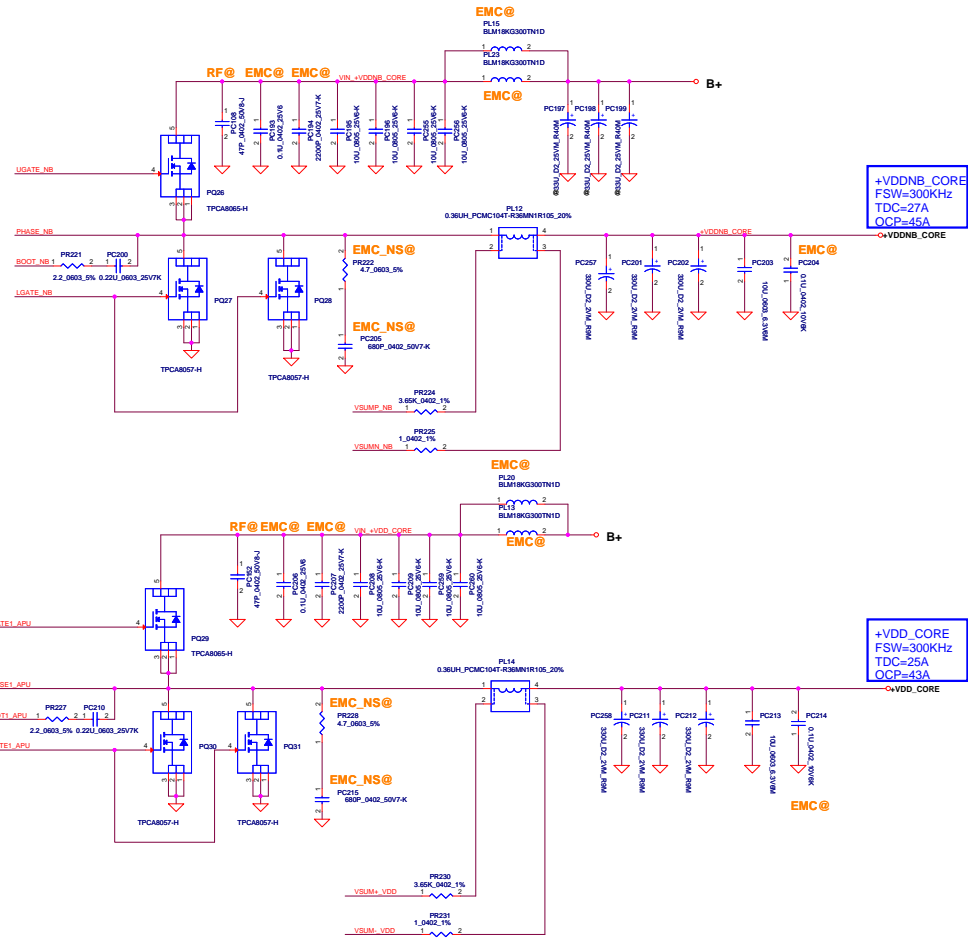


NM-A231


24 1.5VS_VGA_EN



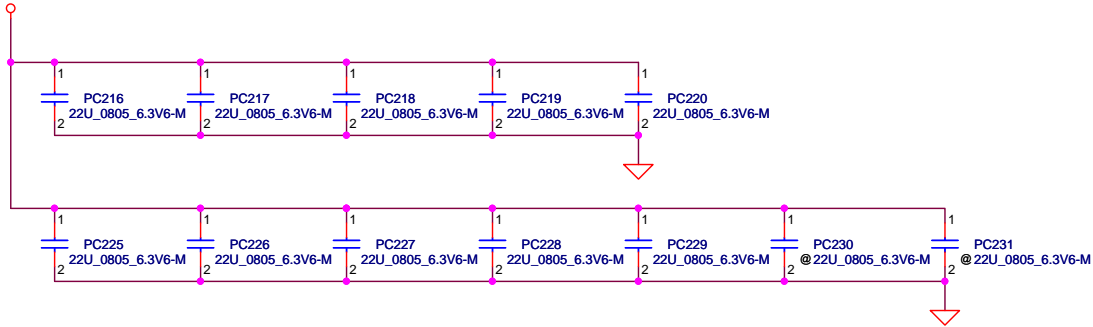
Security Classification		LC Future Center Secret Data		Title +1.5VSP			
Issued Date	2013/08/01	Deciphered Date	2014/08/01				
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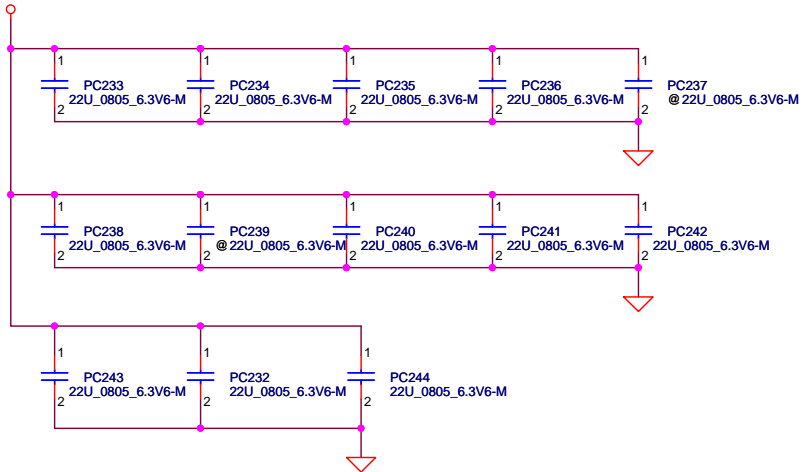
SVC	SVD	Boot Voltage
0	0	1.1V
0	1	1.0V(Default)
1	0	0.9V
1	1	0.8V

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+VDDNB_CORE

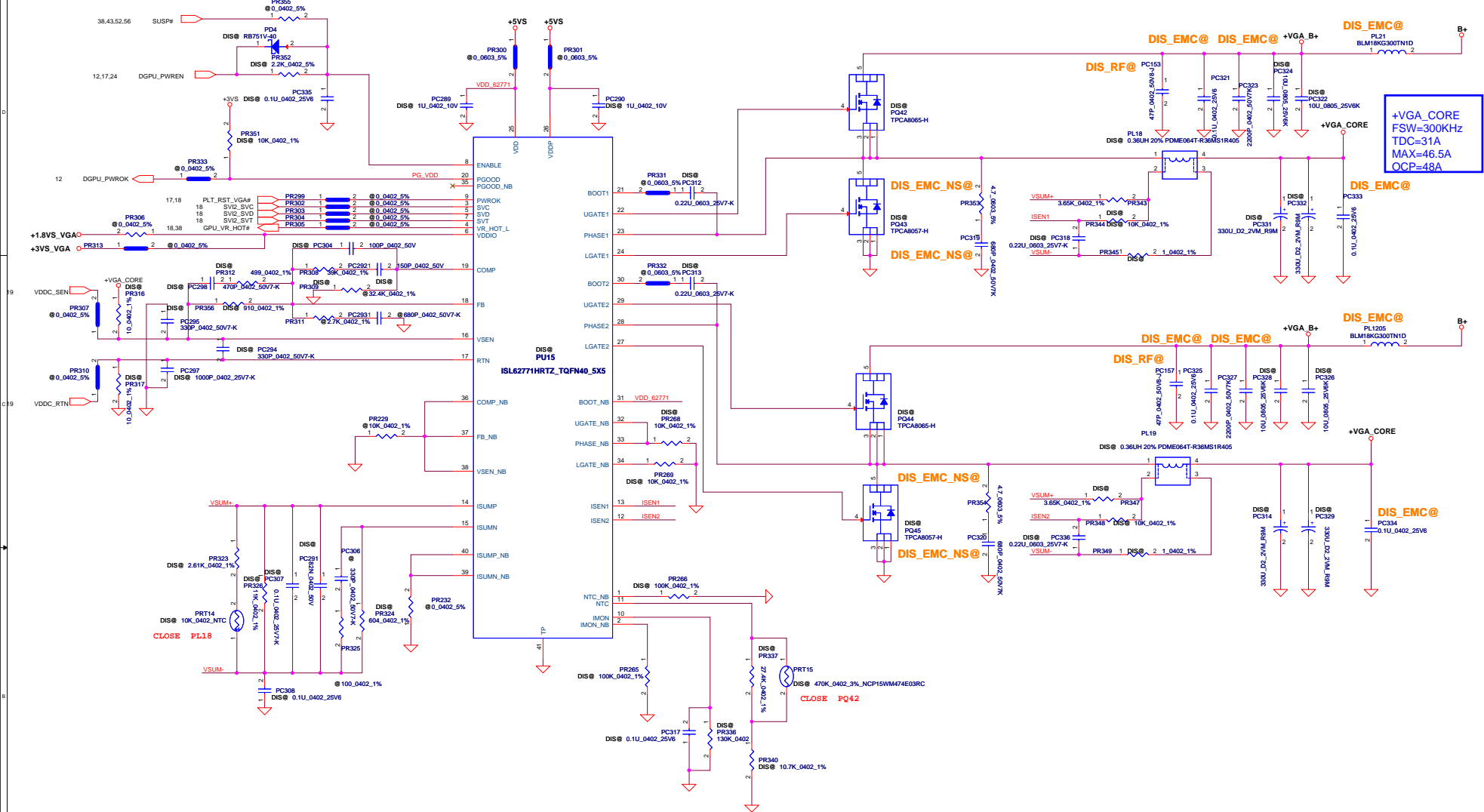


+VDD_CORE




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				Sheet	58 of 65
				Rev	0.2

ISL62771 Schematic for FT3 solution



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Title	+VGA_CORE			Rev
Size Custom	Document Number	<i>NM-A291</i>		0.2
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Item	Reason for change	PG#	Modify List	Date	Phase
1	GPU power sequence tuning	24 12	1.RV132 from 20K ohm change to 3.3K ohm 2.CV165 from 1000PF change to 820PF 3.RV129 from 51K ohm change to 180K ohm 4.RV133 from 47K ohm change to 240K ohm 5.Add DV5 6.RH145 pull down to 1K ohm 7.change RH35 to @ 8.reserver GPU core discharge circiut(RV144, RV143,QV13)	2013.12.26	FVT
2	del double component	38	1.Del RE2, RE3	2013.12.26	FVT
3	EMI request	36	1.CL27 change to 2000V	2013.12.26	FVT
4	Common design	14	1.add RH92 to separate	2013.12.26	FVT
5	System power sequence	43	1.add +3VS discharge circuit Q17,R137 2.change D5 to mount form @	2013.12.26	FVT
6	Common design	43	1.RA2 change to @ , Add RA3 connect to 3VL	2013.12.26	FVT
7	ECSL request	40 24	1.SB000007H1J change to AOS AO3413 SB93413000J(QG1, QV5) 2.SB000002R0J change to LRC LMBT3904WT1G SB000002ZJ00 (Q1,Q8,Q9,QC1,QC2,QV3,,QC4,QC5) 3.SE000000KMT change to SE00000X30T(C1,C3,C99,C140,C141,C146,C147,C148, CA9,CA13,CA14,CA15,CA17,CD22,CV163)	2013.12.26	FVT
8	modify SMBus issue	7	1.QC7, QC6 gate G connect to 1.35V run del RC71,RC72	2013.12.26	FVT
9	Cost down component count	38	1.RE30, RE29, RE11 change to @	2013.12.30	FVT
10	Cost down component count	14	1.RH87 change to @	2013.12.30	FVT
11	Cost down	15	1.RH62 change to mount, LH2 change to @	2013.12.30	FVT
12	Cost down component count	18	1.RV75 change to @	2013.12.30	FVT
13	Cost down component count	18	1.RV82, RV83 change to @	2013.12.30	FVT
14	Cost down component count	18	1.RV150, RV151 change to JET@ from @ 2.RV125, RV122 change to @ form DIS@ 3.CV149,CV150,RV96, RV97,RV95,CV152,CV151,UV9 change to @ form JET@	2013.12.30	FVT
15	Cost down component count	26 7	1.R4, RC73,RC74 change to @	2013.12.30	FVT
16	SMBus issue	7	1.add RC21	2013.12.30	FVT
17	ECSL request	7	1.SA00005QN0Jchange to ANPEC APX3132H SA00005Z200	2013.12.30	FVT
18	Cost down component count	7	1.RC17,18,13, 19 del add RP4	2013.12.30	FVT
19	Cost down component count	7	1.RC47,48,49 del add RP5	2013.12.30	FVT
20	Cost down component count	7	1.RC37,38,39,40 del add RP6	2013.12.30	FVT
21	EC_MUTE# leakage issue	38	1.add D6	2013.1.3	FVT

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Size	Document Number	Rev
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Item	Reason for change	PG#	Modify List	Date	Phase
23	for EC mirro function	38	add D6,RA29 and RE12 change to mount	2013.01.06	FVT
24	BIOS request	14	change GPIO ipin to G-event 5	2013.01.06	FVT
25	PEG signal EA request	7/17	change PEG capacitor to 0.22u, change to 0.1 u	2013.01.06	FVT
26	reduce component count	7/17	DEL RC45,R66, RH70,RH71,RH72,RH73,RH77,RV136,RW4,RW5,RW7,RW8,RW9,RW10	2013.01.06	FVT
27	FAN Pin define reserve	42		2014.02.24	SIV
28	remove GPU CTF function	18	DEL QV3,CV148,RV87,DV1,RV86,RV88,RV74	2014.02.24	SIV
29	remove Fingerprint	42	DEL R111,D25,C136, JFPB	2014.02.24	SIV
30	DFB issue for L9 issue	30	change C54 form @ to mount	2014.02.24	SIV
31	reduce component count		del 0402 R10 R106 R107 R134 RA28 RC43 RE26 RH6 RH7 RH8 RH9 RH10 RH11 RH12 RH13 RH14 RH15 RH16 RH17 RH44 RH22 RH57 RH58 RH76 RH91 RH98 RH90 RH122 RH125 RH126 RH127 RH128 RH129 RH130 RL22 RV150 RV151 0603 R5 R100 R110 RH78 RH79 RH80 RH81 RL4 0805 R8 R37 RA1 RA3 RA4 RA6 RH62 RH61 RH142 RH143	2014.02.24	SIV
32	CP SMB issue	14/42	add R36,R38 for SMB pull up	2014.02.24	SIV
33	component reduce	4	CC1~8,CC106~CC113 change to DIS@	2014.05.14	SVT
34	Audio test request	35	CA 31, CA 32 change to 10u form 4.7u	2014.05.28	SVT
35	Power sequence modify	43	C142 change to 220p form 2200p C143 change to 100p form 1000p	2014.05.28	SVT
36	LAN LED function change	36	LANLED_LINK# connect to pin 10 LANLED_ACT# connect to pin 12	2014.05.28	SVT